

DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

GENERAL DESCRIPTION

This document describes the specification for the IDTF1358 Digital Pre-Distortion Demodulator for PA linearization. This series of devices is offered in 3 variants to cover common UTRA bands.

COMPETITIVE ADVANTAGE

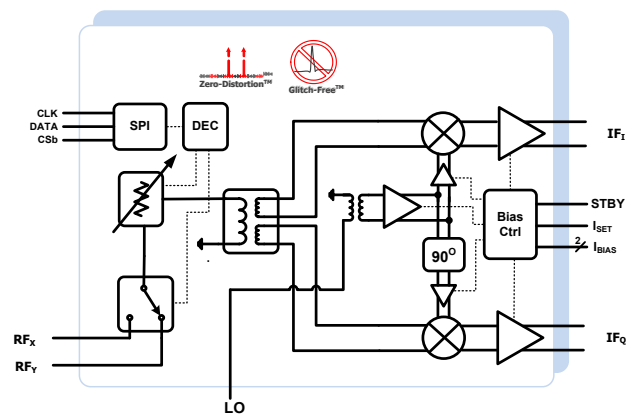
In typical basestation transmitters, digital pre-distortion is employed to improve the Transmitter performance. The signal coming out of the PA is sampled and the incoming Tx chain I&Q data is pre-distorted to counteract the distortion inherent in the PA. The PA signal is adjusted via a digital step attenuator to a lower level and then sub-sampled at an IF frequency of ~200 MHz which necessitates the need for a highly linear demodulator to downmix to quadrature IF from the Transmit frequency. By sampling IF_I and IF_Q independently and then digitally combining these signals, an effective doubling of the sample rate can be achieved. Any distortion in this path will degrade the performance of the DPD algorithm. By utilizing an ultra-linear demodulator w/integrated DSA such as the IDTF1358, the ACLR and/or power consumption of the full Tx system can be improved significantly.

- ✓ GlitchFree™ Technology gives better gain control
- ✓ Zero-Distortion™ eliminates the need for a second IF amplifier in the channel
- ✓ ACLR is reduced for the full channel
- ✓ Power Consumption is reduced by 40%
- ✓ Integrates 2 BPFs, 2 Baluns, and a SPDT RF switch

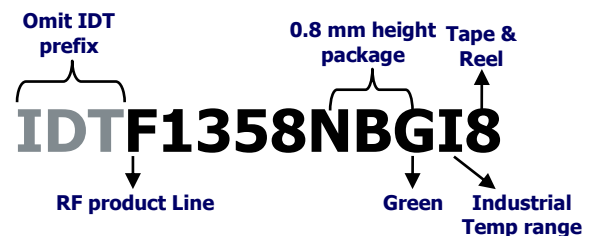
FEATURES

- Wide flat performance IF BW
- Wide RF and LO BWs (~ 800 MHz)
- LO can be High or Low Side
- Ideal for Multi-Carrier Systems
- Drives ADC directly
- Ultra linear +41 dBm OIP3
- Excellent ACLR performance
- 200 Ω output impedance
- Fully integrated DPD demodulator
- Standby Mode w/Fast Recovery
- Current draw is 216 mA
- 6 x 6 mm 36 pin package

FUNCTION BLOCK DIAGRAM



ORDERING INFORMATION



DPD Demodulator for PA Linearization
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ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Units
V _{CC} to GND	V _{CC}	-0.3	+5.5	V
DATA,CSb, CLK, SW_Latch	V _{Logic}	0.0	3.6	V
STBY	V _{Logic-Stby}	0.0	V _{CC}	
IF_I+, IF_I-, IF_Q+, IF_Q-, RF_INX, RF_INY	I _{IF}	1.00	V _{CC} + 0.30	V
LO_IN	V _{LO}	-0.3	+0.30	V
LO_ADJ to Ground	V _{LObias}	+2.1	+4.0	V
IF_BiasI, IF_BiasQ to Ground	V _{IFbias}	-0.3	+1.20	V
Maximum RF Input Power (RFIN_X, RFIN_Y)	P _{RFIN}		+27	dBm
Continuous Power Dissipation	P _{diss}		2.5	W
Junction Temperature	T _j		150	°C
Storage Temperature Range	T _{st}	-65	150	°C
Lead Temperature (soldering, 10s)			260	°C
ElectroStatic Discharge – HBM (JEDEC/ESDA JS-001-2012)			1000 (Class 1C)	Volts
ElectroStatic Discharge – CDM (JEDEC 22-C101F)			500 (Class C4)	Volts

Stresses above those listed above may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

This product features proprietary protection circuitry. However, it may be damaged if subjected to high energy ESD. Please use proper ESD precautions when handling to avoid damage or loss of performance.


PACKAGE THERMAL AND MOISTURE CHARACTERISTICS

θ_{JA} (Junction – Ambient)	40 °C/W
θ_{JC} (Junction – Case) [The Case is defined as the exposed paddle]	3 °C/W
Moisture Sensitivity Rating (Per J-STD-020)	MSL1

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F1358 RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage(s)	V_{CC}	All VCC pins	4.75	5.00	5.25	V
Operating Temperature Range	T_{CASE}	Case Temperature	-40		105	°C
RF Freq Range - Linearity	F_{RF-LIN}	ATTN = 0 dB $P_{RF} = -11$ dBm/Tone $F_{IF} = 200$ MHz OIP3 > +35 dBm	3200		4000	MHz
RF Freq Range - Oversampled	F_{RF-OS}	ATTN = 0 dB RF_INX $F_{LO} = 3180-3500$ MHz Gain Delta < 2.5 dB	3200		4000	MHz
LO Freq Range	F_{LO}		3100		3800	MHz
LO Power	P_{LO}		-3		3	dBm
IF Freq Range - Linearity	F_{IF-LIN}	ATTN = 0 dB RF_INX $P_{RF} = -11$ dBm/Tone $F_{RF} = 3600$ MHz OIP3 > +35 dBm	100		300	MHz
IF Freq Range- Oversampled	F_{IF-OS}	ATTN = 0 dB RF_INX $F_{LO} = 3180-3500$ MHz Gain Delta < 2.5 dB	20		500	MHz
RF Source Impedance	Z_{RF_INX} Z_{RF_INY}	Single Ended		50		Ω
LO Source Impedance	Z_{LO}	Single Ended		50		Ω
IF Load Impedance	Z_{IF_I} Z_{IF_O}	Differential		200		Ω

DPD Demodulator for PA Linearization
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F1358 SPECIFICATION

Specifications apply at $V_{CC} = +5.00$ V, $T_{CASE} = +25$ °C, $F_{RF} = 3455$ MHz, G_{max} , $P_{RF} = -11$ dBm, $F_{LO} = 3255$ MHz, $P_{LO} = 0$ dBm, $STBY = GND$, $V_{IH} = 3.3$ V, $V_{IL} = 0.0$ V unless otherwise noted. Trace, Connector, and external transformer losses are de-embedded.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Logic Input High	V_{IH}	All Control Pins	2			V
Logic Input Low	V_{IL}	All Control Pins			0.5	V
Logic Current	I_{IH}, I_{IL}	All Control Pins	-130		+10	μ A
Standby Mode Logic	STBY	STBY = V_{IH}	Power OFF			
		STBY = V_{IL}	Power ON			
Supply Current	I_{CC_ON}		180	216	250¹	mA
	I_{CC_STBY}	Standby Mode		20	25	
Attenuator Range				25.5		dB
Attenuator Step	LSB			0.5		dB
Gain	G_{max}	ATTN = 0 dB	8.7	10.2	11.7	dB
	G_{min}	ATTN = 25.5 dB	-16.5	-15	-13.5	
Return Loss, RF ports	S_{RFX}, S_{RFY}			16		dB
Return Loss, LO port	S_{LO}			15		dB
Return Loss, IF ports	S_{IFI}, S_{IFI}	Single Ended		20		dB
Noise Figure	NF_0	ATTN = 0 dB		19		dB
Output IP3	$OIP3_0$	ATTN = 0 dB	36	41		dBm
	$OIP3_{20}$	ATTN = 20 dB, $P_{RF} = +9$ dBm		42		
Output IP2	$OIP2_0$	ATTN = 0 dB		59		dBm
Second Harmonic	$H2_0$	ATTN = 0 dB, $P_{IF} = -6$ dBm		-72		dBc
Input Compression	IP1dB- C_0	ATTN = 0 dB Gain delta for RF input power set at +5 dBm and RF Input power set at -11 dBm.		0.2	1	dB
Gain Ripple	G_{ripple}	$F_{LO} = 3380$ MHz $F_{RF} = 3400$ to 3880 MHz		1.6	2.5^2	dB
Group Delay Distortion	GDD	$F_{LO} = 3380$ MHz $F_{RF} = 3400$ to 3880 MHz		5		ns
Attenuator Step Accuracy	DNL			0.2		dB
Absolute Attenuator Accuracy	INL		-0.75	-0.1	0.75	dB

Note 1: Items in min/max columns in **bold italics** are Guaranteed by Test.

Note 2: Items in min/max columns that are not bold/italics are Guaranteed by Design Characterization.

Note 3: Timing measurements are measured after SPI programming is completed (data latched with LE = HIGH).

Note 4: Gain across the entire frequency band is affected by the inclusion of the RF switch.

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F1358 SPECIFICATION

Specifications apply at $V_{CC} = +5.00\text{ V}$, $T_{CASE} = +25\text{ }^{\circ}\text{C}$, $F_{RF} = 3455\text{ MHz}$, G_{max} , $P_{RF} = -11\text{ dBm}$, $F_{LO} = 3255\text{ MHz}$, $P_{LO} = 0\text{ dBm}$, $STBY = GND$, $V_{IH} = 3.3\text{ V}$, $V_{IL} = 0.0\text{ V}$ unless otherwise noted. Trace, Connector, and external transformer losses are de-embedded.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Quadrature Amplitude Balance	BAL_G	Over Oversampled Range	-0.3		0.3	dB
Quadrature Amplitude Balance over environmental	$BAL_{G\Delta}$	$T_{Amb} = -40\text{ to }+85\text{ }^{\circ}\text{C}$ $P_{LO} = -3\text{ to }+3\text{ dBm}$	-0.5		+0.5	dB
Quadrature Phase Balance	BAL_{ϕ}		-1	0.3	1.5	degrees
Quadrature Phase Balance over environmental	$BAL_{\phi\Delta}$	$T_{Amb} = -40\text{ to }+85\text{ }^{\circ}\text{C}$ $P_{LO} = -3\text{ to }+3\text{ dBm}$	-1.5	0.5	+2.5	degrees
LO to IF Leakage	ISO_{LI}	Output Balun not de-embedded.		-37	-32	dBm
RF to IF Isolation	ISO_{RI}	Output Balun not de-embedded. Reference to P_{IF} .		-42	-32	dBc
LO to RF Leakage	ISO_{LR}			-41		dBm
RF Switch Isolation	$ISO_{RFX-RXY}$			-40		dB
Switch Time		RF_INX: 3600 MHz, -11 dBm LO: 3415 MHz, 0 dBm 50% CSb to 10%/90% settled to within 0.1dB of final value of power at IF_I.				ns
	τ_{EN_ON}	EN Bit set high		100		
	τ_{EN_OFF}	EN Bit set low		50		
	τ_{RF_XY}	Switched from RF_INX to RF_INY. No power at RF_INY.		150		
	τ_{RF_YX}	Switched from RF_INY to RF_INX. No power at RF_INY		200		
DSA Settling time		RF_INX: 3600 MHz, -11 dBm LO: 3415 MHz, 0 dBm 50% CSb to 10%/90% settled to within 0.1dB of final value of power at IF_I.				ns
	τ_{SET}					
	τ_{SET1}	ATTN= 0.0 dB to 25.5 dB		300		
	τ_{SET2}	ATTN= 25.5 dB to 0.0 dB		300		
	τ_{SET3}	ATTN= 15.5 dB to 16.0 dB		250		
	τ_{SET4}	ATTN= 16.0 dB to 15.5 dB		250		
Control Interface	SPI_{BIT}			16		bit
Serial Clock Speed	SPI_{CLK}			20	50	MHz

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Note 2: Items in min/max columns that are not bold/italics are Guaranteed by Design Characterization.

Note 3: Timing measurements are measured after SPI programming is completed (data latched with CSb = HIGH).

Note 4: Gain across the entire frequency band is affected by the inclusion of the RF switch.

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POWER-ON SEQUENCE

The power-on sequence will ensure that the F1358 works in the default mode once powered on. If the F1358 is programmed after applying DC power, the following power-on sequence is not needed.

Note: To use power on sequence, SW_LATCH cannot be grounded permanently.

The power-on sequence should be:

1. CSb & SW_LATCH must be set low at power-on.
2. Once powered on, first set SW_LATCH high, then set CSb high.
3. Proceed with normal programming.

The default state after using power-on sequence:

- Maximum attenuation
- RF_INX selected
- Normal operation (not Standby Mode)

REGARDING PHASE OF I & Q:

- When LO is high-side injected, IF_I leads IF_Q by 90 degrees
- When LO is low-side injected, IF_Q leads IF_I by 90 degrees

OPERATING MODE

There are two hardware pin, STBY on Pin 14 SW_Latch on Pin 1, which allows multiple operating modes.

Table 1 - Operating Mode Logic Table

STBY	SW_Latch	Mode	Write Access	Comment
0	0	Operating Mode	A2,A0 Enabled, D7:D0 Enabled	RF Switch control (A2). Software Standby allowed (A0). Attenuator control (D7:D0).
0	1	Operating Mode	A2,A0 Disabled, D7:D0 Enabled	No RF Switch control. No Software Standby allowed. Attenuator control (D7:D0).
1	0	Off	A2,A0 Enabled, D7:D0 Enabled	RF Switch control (A2). Software Standby allowed (A0). Attenuator control (D7:D0). Device is in Standby mode.
1	1	Off	A2,A0 Disabled, D7:D0 Enabled	No RF Switch control. No Software Standby allowed. Attenuator control (D7:D0). Device is in Standby mode.

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SERIAL CONTROL MODE

Data is clocked in MSB first via serial mode. Serial data is formatted as a 16-bit word. The 16-bit word contains logic for switching the RF switch, 6-bit attenuator setting, and Enabling (software standby). Each word contains the following sequence:

Table 2 - 16 Bit SPI Word Sequence

A7	Reserved
A6	Reserved
A5	Reserved
A4	Reserved
A3	Reserved
A2	RF Switch
A1	Reserved
A0	Enable Off=0, On=1
D7	Reserved
D6	Attenuator 16 dB Control Bit
D5	Attenuator 8 dB Control Bit
D4	Attenuator 4 dB Control Bit
D3	Attenuator 2 dB Control Bit
D2	Attenuator 1 dB Control Bit
D1	Attenuator 0.5 dB Control Bit
D0	Reserved

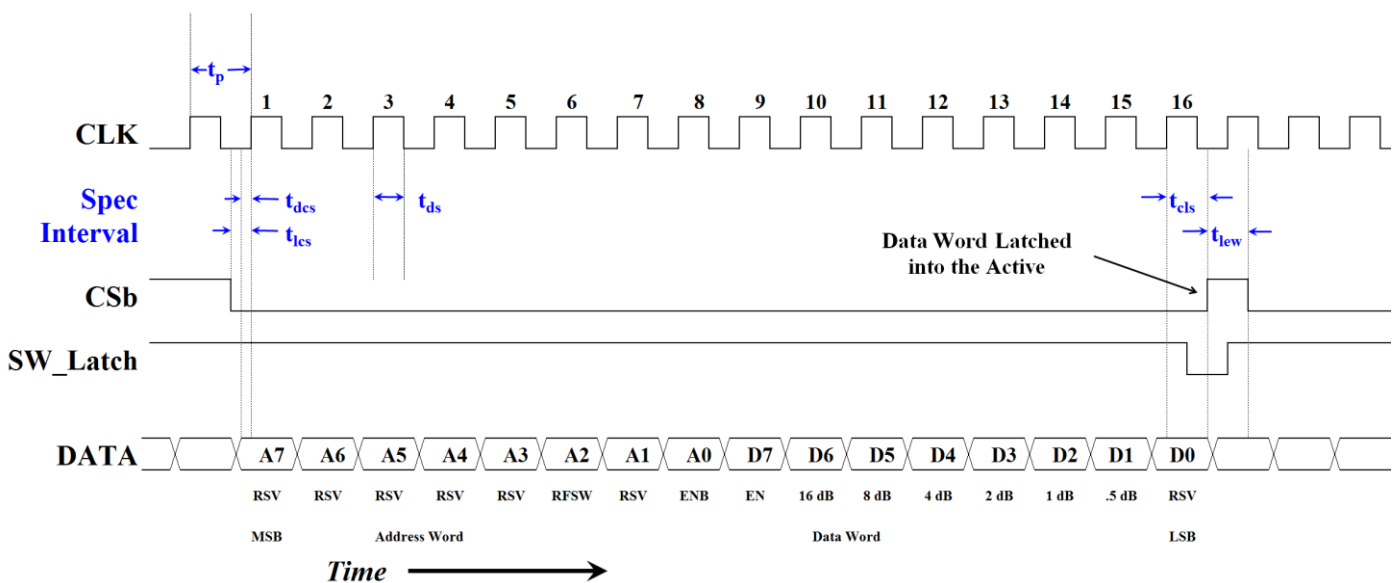


Figure 1 - Serial Register Timing Diagram

Table 3 - Serial Mode Timing Table

Interval Symbol	Description	Min Spec	Max Spec	Units
t_p	Clock Pulse Width	10		ns
t_{ds}	Clock high pulse width	5		ns
t_{cls}	Clock to CSb Hold Time. From the rising edge of CLK pulse for D0 to CSb rising edge minus half the clock period.	10		ns
t_{lew}	CSb pulse width	3		ns
t_{dcs}	Data Setup Time - From the starting edge of Data bit to rising edge of CLK	3		ns
t_{dht}	Data Hold Time - From rising edge of CLK to falling edge of the Data bit.	10		ns

To program the serial interface:

If CSb is de-asserted (set to high), the serial interface will ignore the CLK line. Once CSb is asserted (set to low), the serial interface will recognize the CLK and any data present on DATA will be clocked into the registers with each rising CLK edge. After the 16th CLK cycle, and before the 17th CLK cycle, CSb must be de-asserted to successfully program the part with the desired bytes. If CSb is de-asserted before the 16th CLK cycle, or after the 17th CLK cycle, there is no guarantee that the correct bytes will be programmed and the user will have to re-program the interface in accordance with the aforementioned procedure.

SW_LATCH programming sequence

- When SW_LATCH is pinned high during the programming sequence, "RFSW" and "ENb" registers cannot be programmed and therefore will not toggle.
- If SW_LATCH is pinned low during the programming sequence, the "RFSW" and "ENb" register will toggle. This can be prevented with the "Programming Sequence" below.

Sequence for programming registers A2, A0

1. SW_Latch = 1; CSb = 0
2. CLK in 8- or 16-bit word, do not de-assert (pull high) CSb
3. Set SW_LATCH = 0 while CSb = 0 remains)
4. With SW_Latch = 0, set CSb = 1
5. Set SW_Latch = 1
6. Program complete

F1358 Attenuation Table

The F1358 attenuation setting is controlled by 6 bits in the data word. The device provides for an attenuation range from 0 dB to 25.5 dB in 0.5 dB steps. A "high" or "1" bit corresponds to attenuation stepped IN, while a "low" or "0" bit corresponds to attenuation stepped OUT.

Because the first and last bits of the Data Word are not presently used by the F1358, two additional hex character pairs exist for each of those in this table. For example, data words of either H00, H80, or H01 (binary "00000000," "10000000," or "00000001") will place the F1358 in its minimum attenuation state.

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Likewise, data words of either H66, HE6, or H67 (binary "01100110" or "11100110" or "01100111") will place the F1358 in its maximum attenuation state of 25.5 added attenuation.

Table 4 - Attenuation Digital Word Table

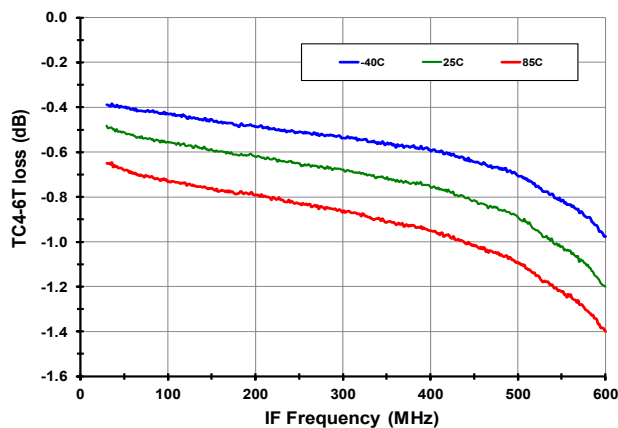
State	Attenuation (dB)	Hex	Binary D7 – D0	State	Attenuation (dB)	Hex	Binary D7 – D0
0	0.0	00	00000000	26	13.0	34	00110100
1	0.5	02	00000010	27	13.5	36	00110110
2	1.0	04	00000100	28	14.0	38	00111000
3	1.5	06	00000110	29	14.5	3A	00111010
4	2.0	08	00001000	30	15.0	3C	00111100
5	2.5	0A	00001010	31	15.5	3E	00111110
6	3.0	0C	00001100	32	16.0	40	01000000
7	3.5	0E	00001110	33	16.5	42	01000010
8	4.0	10	00010000	34	17.0	44	01000100
9	4.5	12	00010010	35	17.5	46	01000110
10	5.0	14	00010100	36	18.0	48	01001000
11	5.5	16	00010110	37	18.5	4A	01001010
12	6.0	18	00011000	38	19.0	4C	01001100
13	6.5	1A	00011010	39	19.5	4E	01001110
14	7.0	1C	00011100	40	20.0	50	01010000
15	7.5	1E	00011110	41	20.5	52	01010010
16	8.0	20	00100000	42	21.0	54	01010100
17	8.5	22	00100010	43	21.5	56	01010110
18	9.0	24	00100100	44	22.0	58	01011000
19	9.5	26	00100110	45	22.5	5A	01011010
20	10.0	28	00101000	46	23.0	5C	01011100
21	10.5	2A	00101010	47	23.5	5E	01011110
22	11.0	2C	00101100	48	24.0	60	01100000
23	11.5	2E	00101110	49	24.5	62	01100010
24	12.0	30	00110000	50	25.0	64	01100100
25	12.5	32	00110010	51	25.5	66	01100110

DPD Demodulator for PA Linearization
TYPICAL OPERATING CONDITIONS (TOC)

3200 MHz to 4000 MHz

Unless otherwise noted for the TOC graphs on the following pages, the following conditions apply.

- **IF = 200 MHz**
- **Tone spacing = 5 MHz**
- **Pin = -11 dBm / Tone**
- **Pout ~ 0 dBm / Tone**
- **RF_INX, IF_Q selected**
- **Minimum Attenuation selected (0 dB ATTN)**
- **VCC = 5.00 V**
- **LO level = 0 dBm**
- **Case Temperature = +25 °C**
- **All Temperatures are Case Temperature (T_{CASE})**
- **Output Transformers are de-embedded**
- **Input RF trace losses are de-embedded**



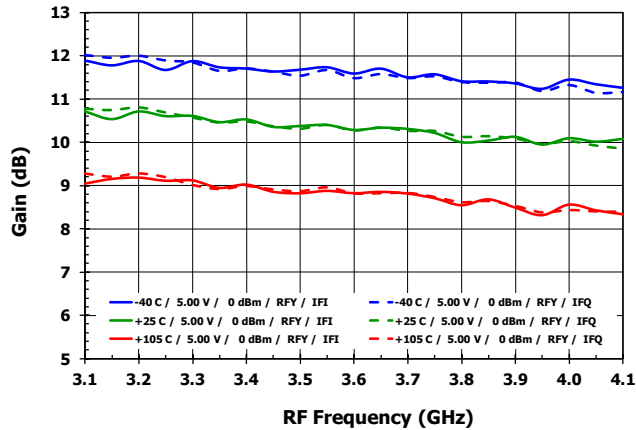


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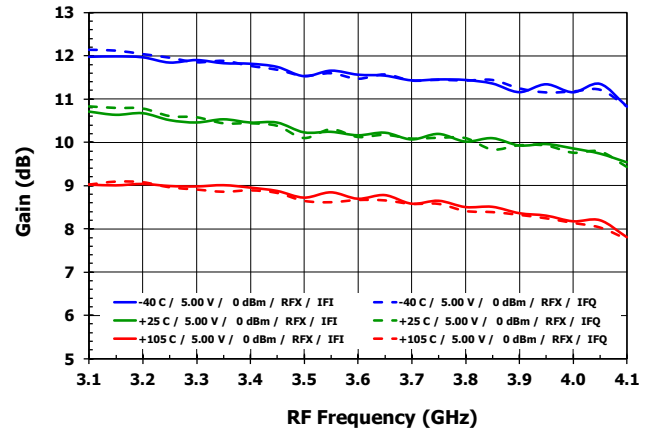
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 1 -)

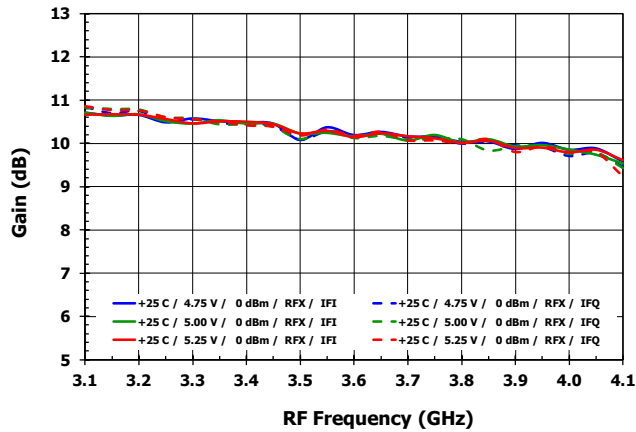
Gain vs. T_{case} [Low Side LO, RF_X]



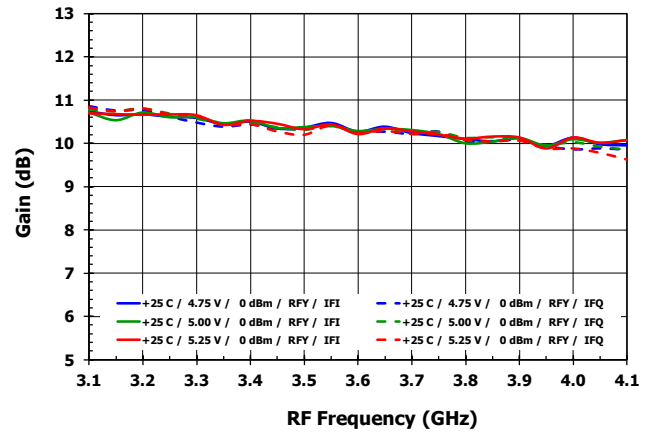
Gain vs. T_{case} [Low Side LO, RF_Y]



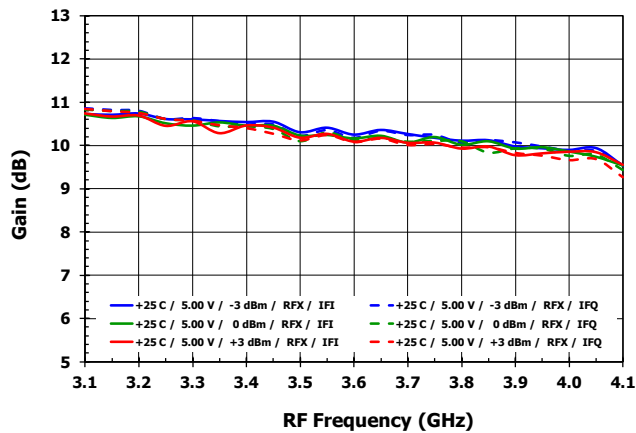
Gain vs. V_{cc}[Low Side LO, RF_X]



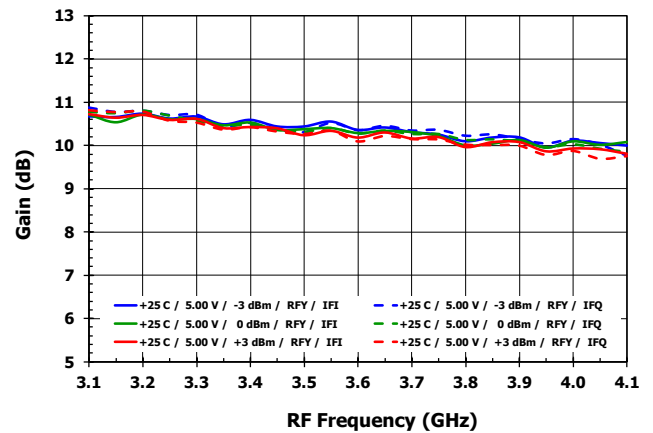
Gain vs. V_{cc}[Low Side LO, RF_Y]



Gain vs. LO Power [Low Side LO, RF_X]



Gain vs. LO Power [Low Side LO, RF_Y]

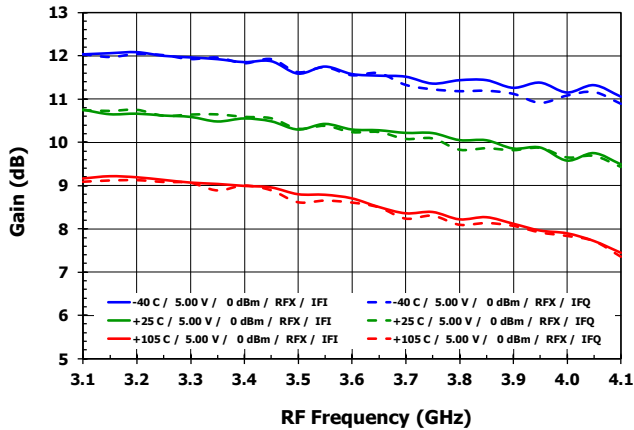


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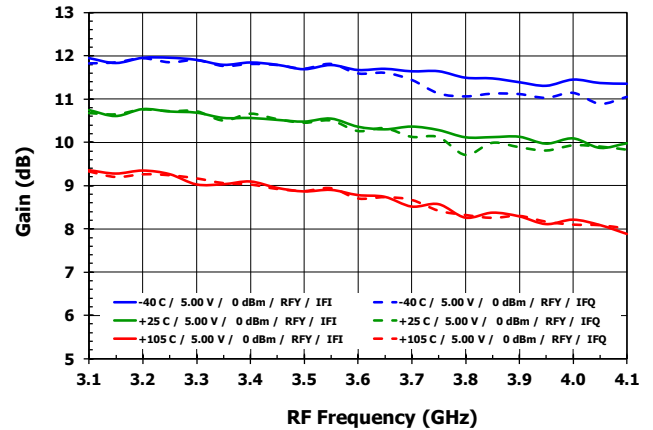
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 2 -)

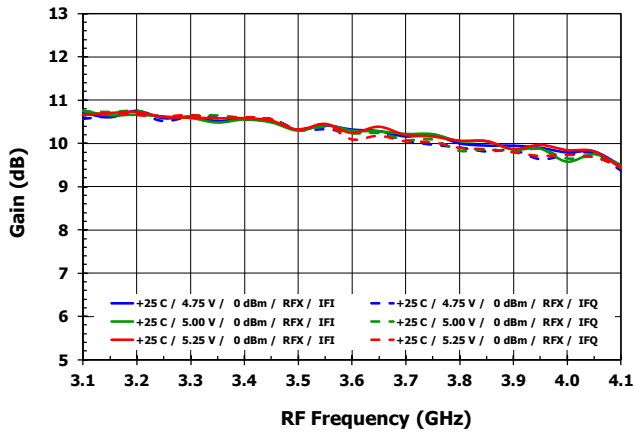
Gain vs. T_{case} [High Side LO, RF_X]



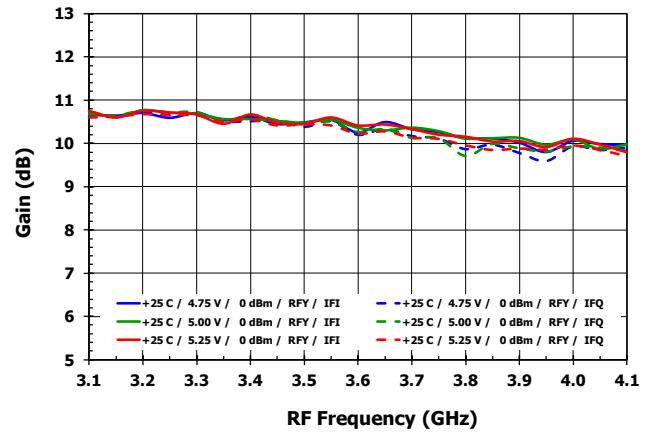
Gain vs. T_{case} [High Side LO, RF_Y]



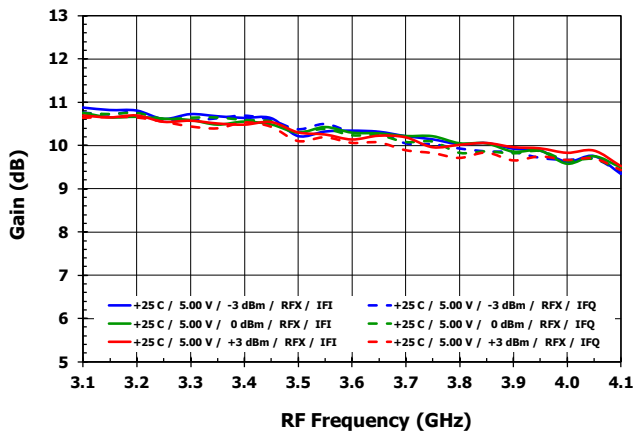
Gain vs. V_{cc} [High Side LO, RF_X]



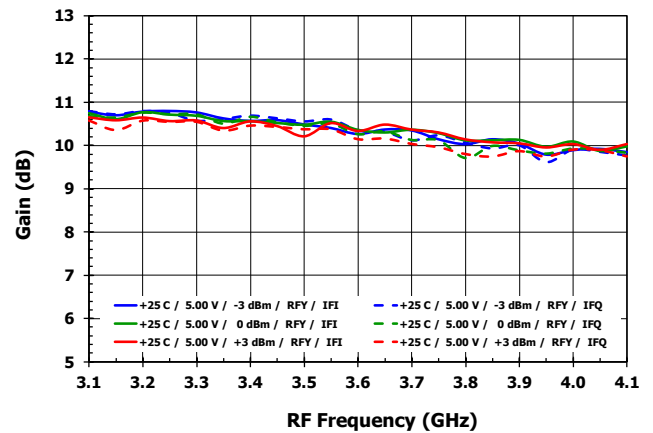
Gain vs. V_{cc} [High Side LO, RF_Y]



Gain vs. LO Power [High Side LO, RF_X]



Gain vs. LO Power [High Side LO, RF_Y]

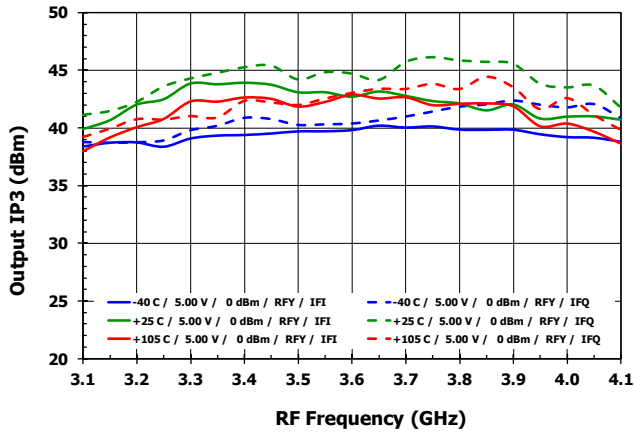


DPD Demodulator for PA Linearization

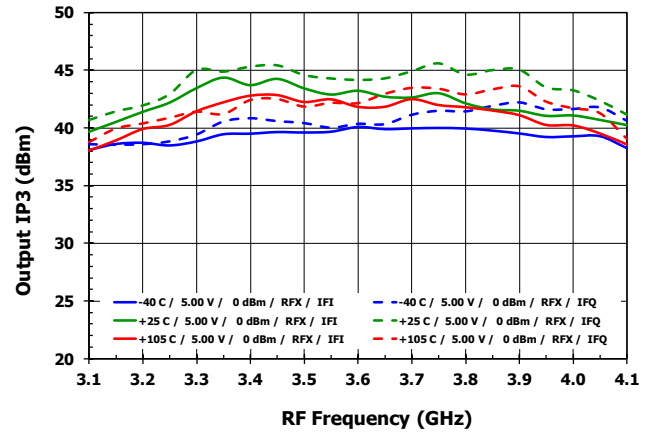
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 3 -)

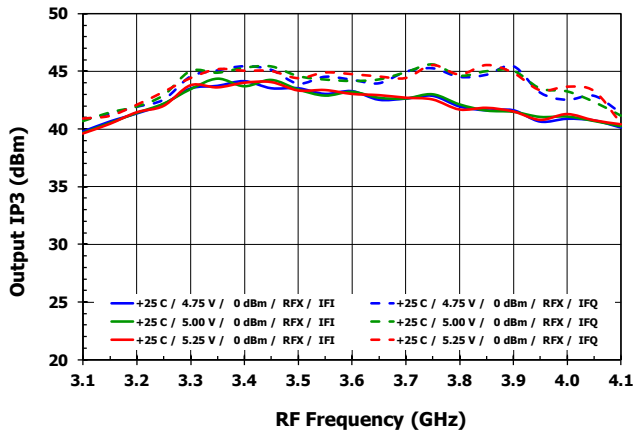
OIP3 vs. T_{case} [Low Side LO, RF_X]



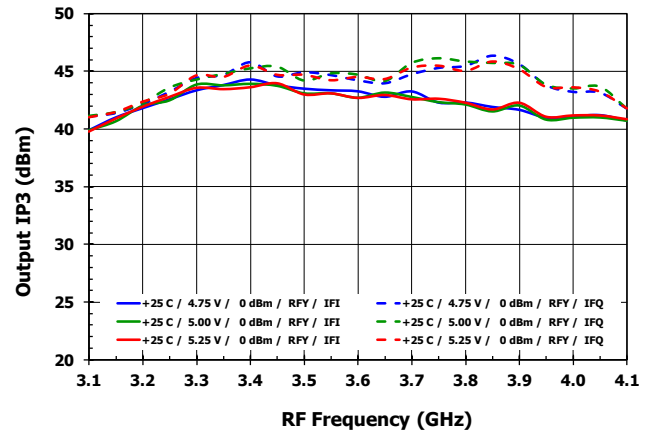
OIP3 vs. T_{case} [Low Side LO, RF_Y]



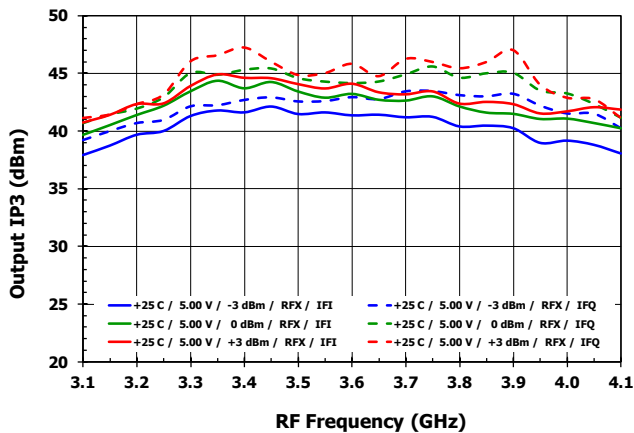
OIP3 vs. V_{cc} [Low Side LO, RF_X]



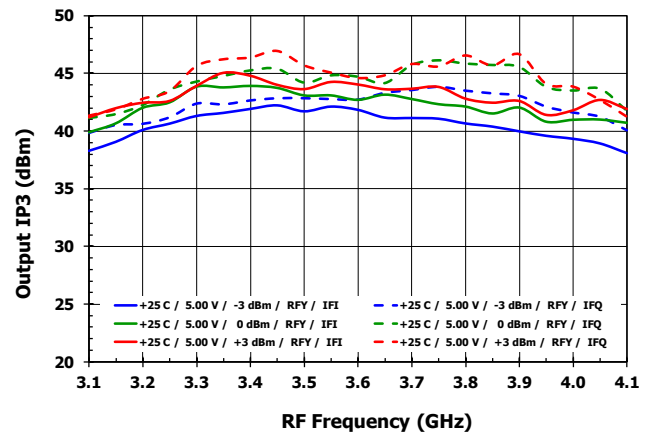
OIP3 vs. V_{cc} [Low Side LO, RF_Y]



OIP3 vs. LO Power [Low Side LO, RF_X]



OIP3 vs. LO Power [Low Side LO, RF_Y]

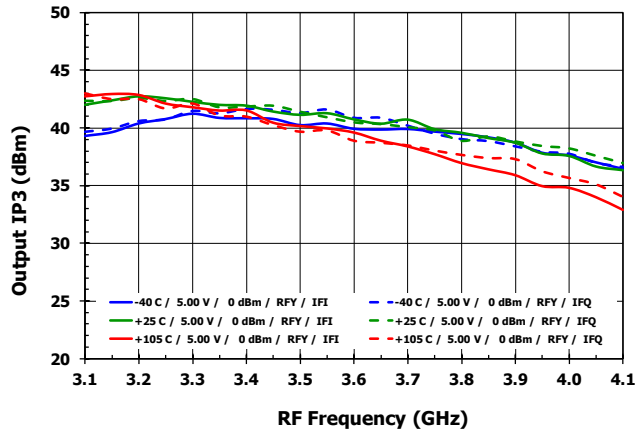


DPD Demodulator for PA Linearization

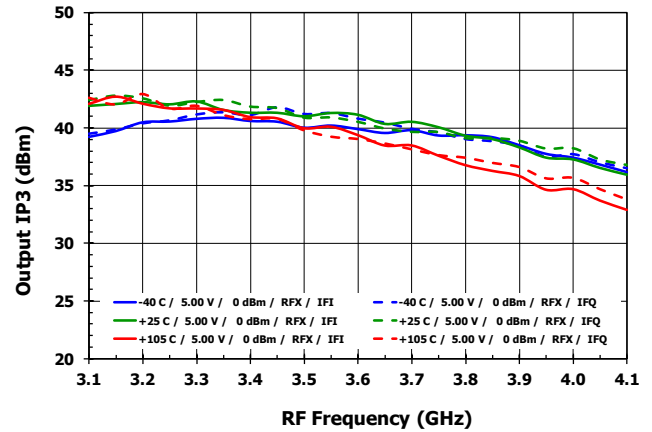
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 4 -)

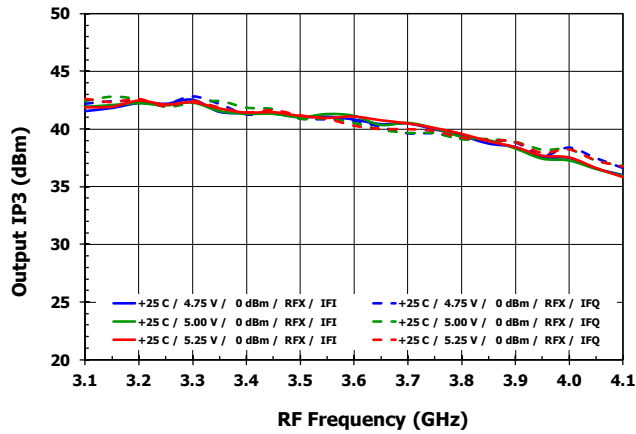
OIP3 vs. T_{case} [High Side LO, RF_X]



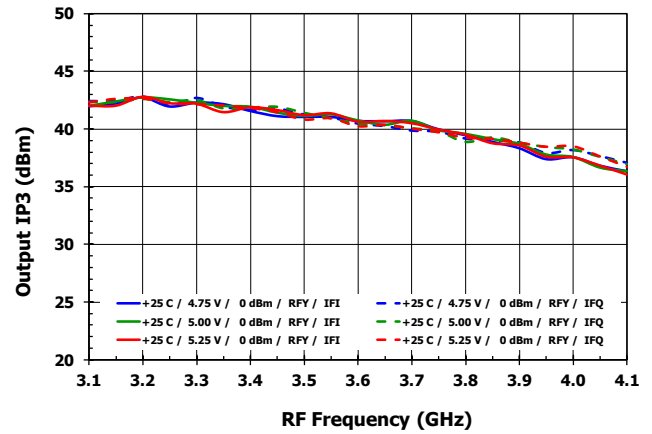
OIP3 vs. T_{case} [High Side LO, RF_Y]



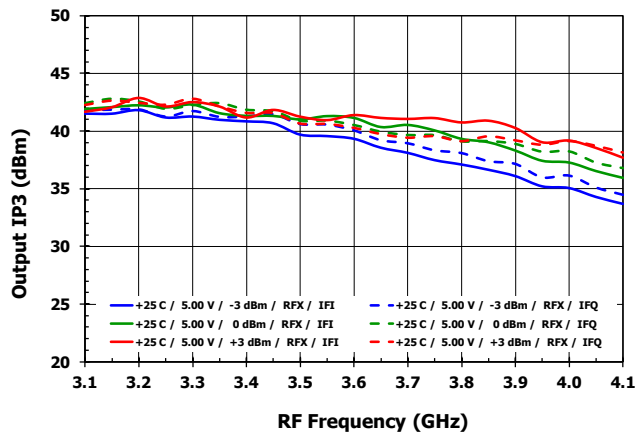
OIP3 vs. V_{cc} [High Side LO, RF_X]



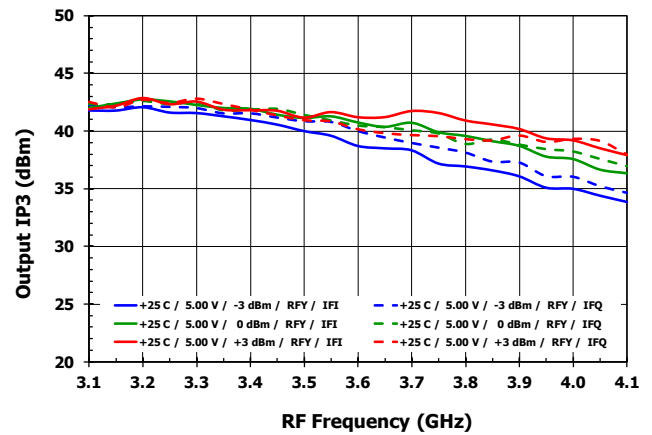
OIP3 vs. V_{cc} [High Side LO, RF_Y]



OIP3 vs. LO Power [High Side LO, RF_X]



OIP3 vs. LO Power [High Side LO, RF_Y]



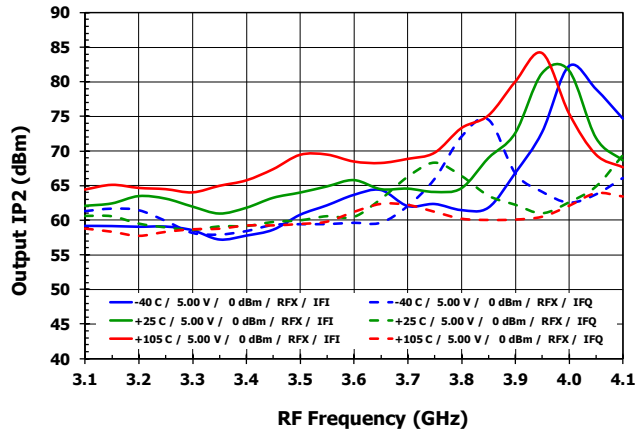


DPD Demodulator for PA Linearization

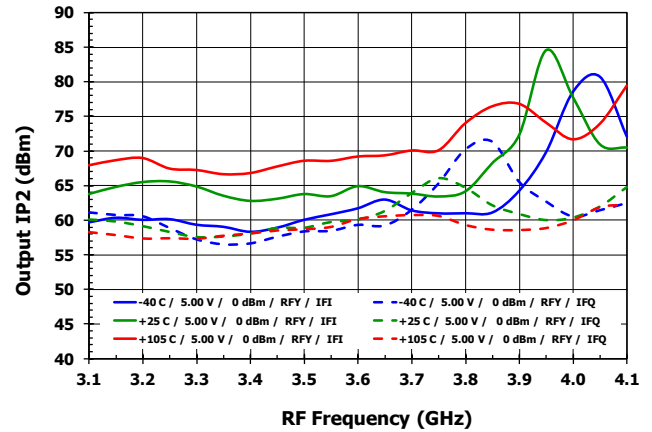
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 5 -)

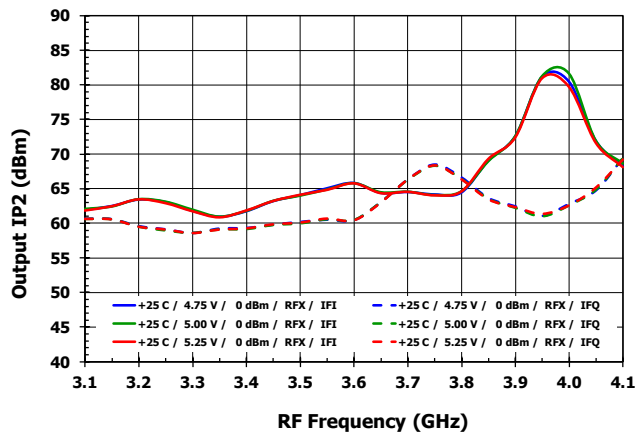
OIP2 vs. T_{case} [Low Side LO, RF_X]



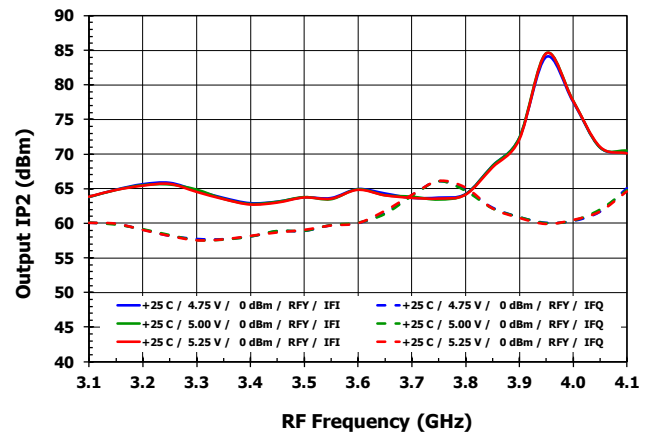
OIP2 vs. T_{case} [Low Side LO, RF_Y]



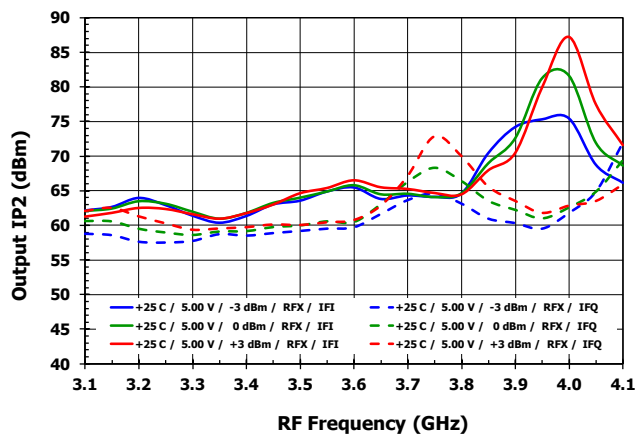
OIP2 vs. V_{cc}[Low Side LO, RF_X]



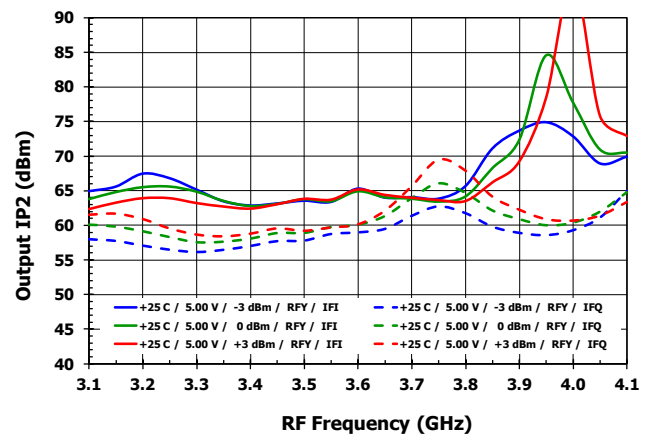
OIP2 vs. V_{cc}[Low Side LO, RF_Y]



OIP2 vs. LO Power [Low Side LO, RF_X]



OIP2 vs. LO Power [Low Side LO, RF_Y]

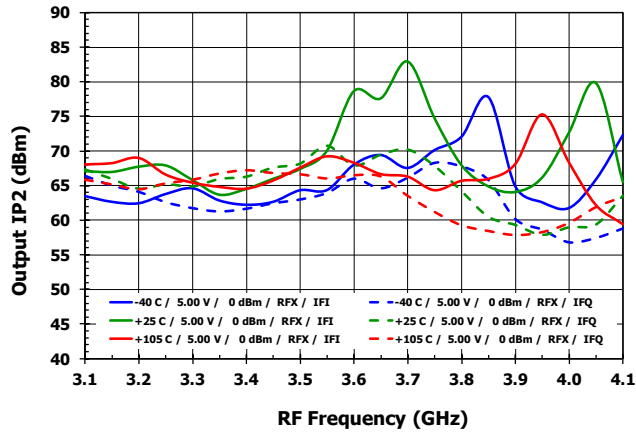


DPD Demodulator for PA Linearization

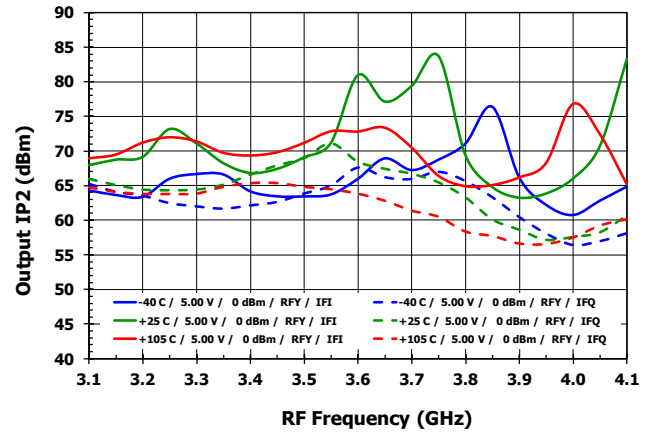
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 6 -)

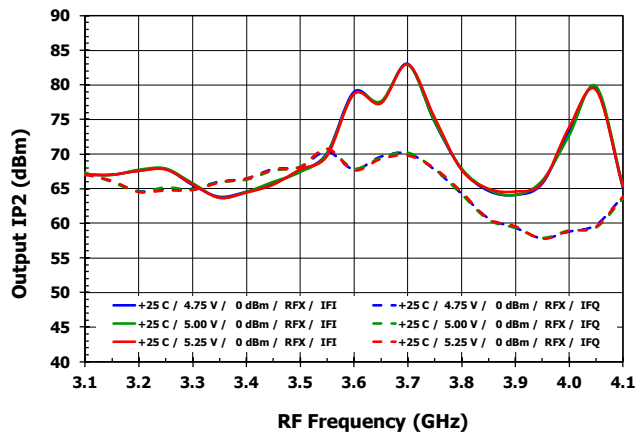
OIP2 vs. T_{case} [High Side LO, RF_X]



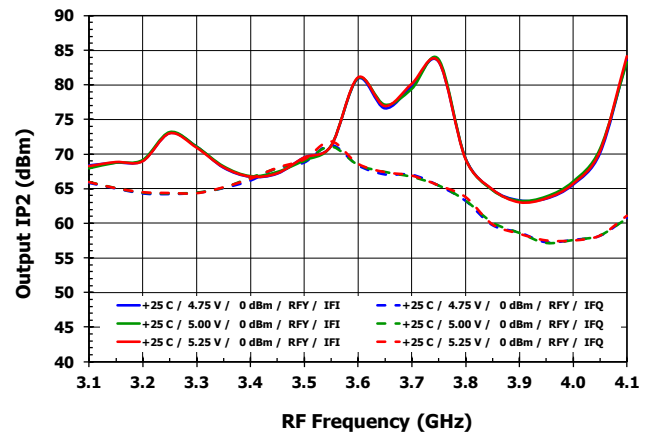
OIP2 vs. T_{case} [High Side LO, RF_Y]



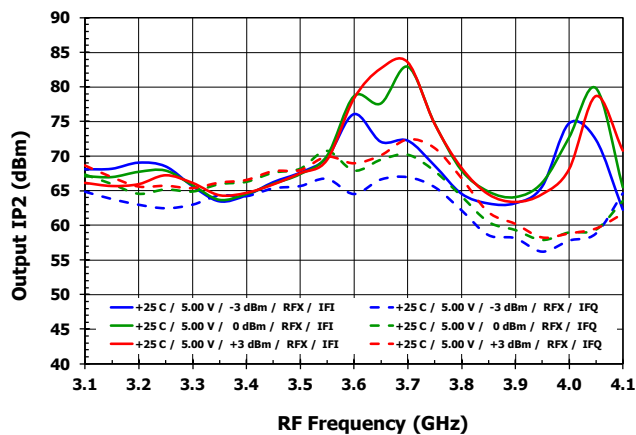
OIP2 vs. V_{cc} [High Side LO, RF_X]



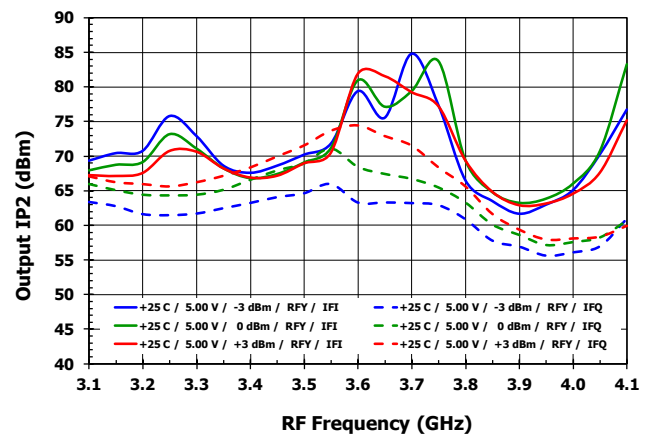
OIP2 vs. V_{cc} [High Side LO, RF_Y]



OIP2 vs. LO Power [High Side LO, RF_X]



OIP2 vs. LO Power [High Side LO, RF_Y]

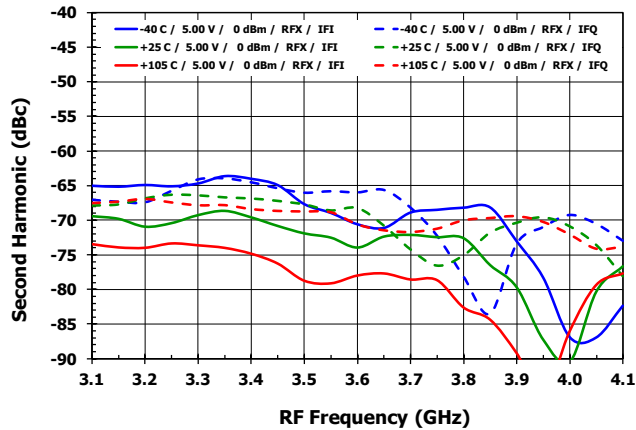


DPD Demodulator for PA Linearization

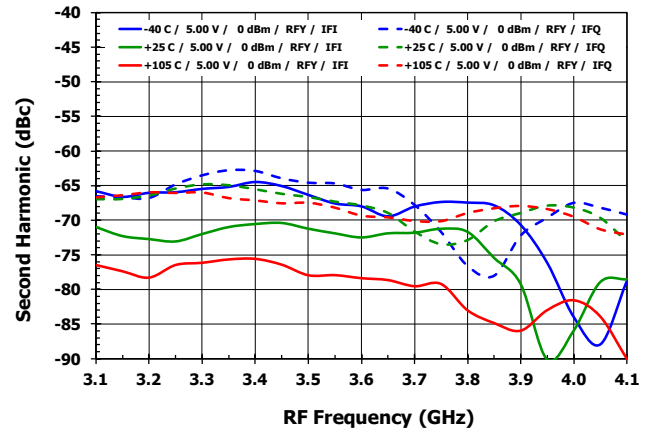
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 7 -)

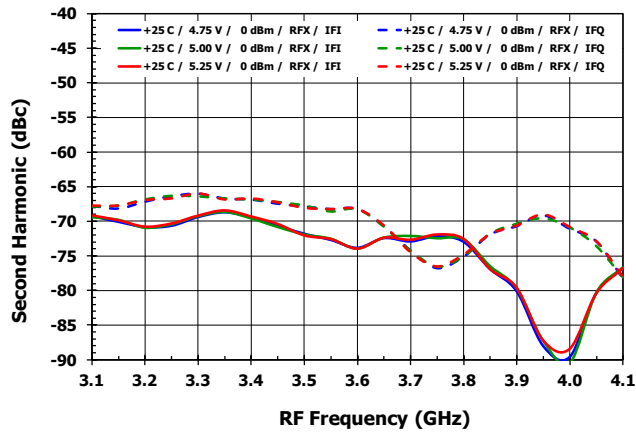
2nd Harmonic vs. T_{case} [Low Side LO, RF_X, P_{IF} = -6 dBm]



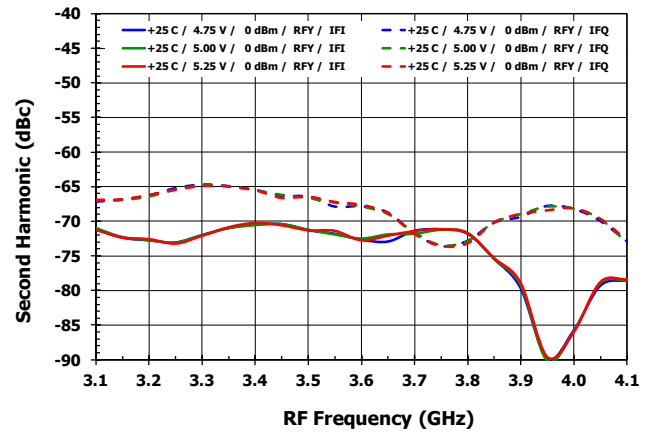
2nd Harmonic vs. T_{case} [Low Side LO, RF_Y, P_{IF} = -6 dBm]



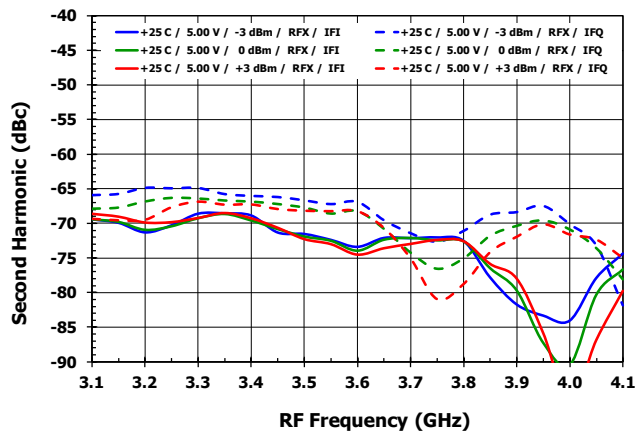
2nd Harmonic vs. V_{cc} [Low Side LO, RF_X, P_{IF} = -6 dBm]



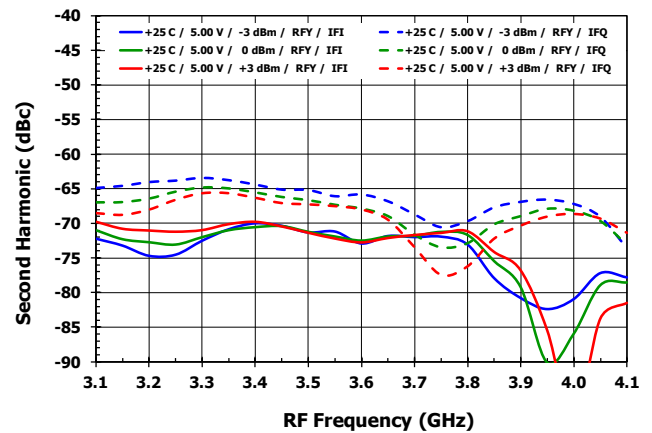
2nd Harmonic vs. V_{cc} [Low Side LO, RF_Y, P_{IF} = -6 dBm]



2nd Harmonic vs. LO Power [Low Side LO, RF_X, P_{IF} = -6 dBm]



2nd Harmonic vs. LO Power [Low Side LO, RF_Y, P_{IF} = -6 dBm]



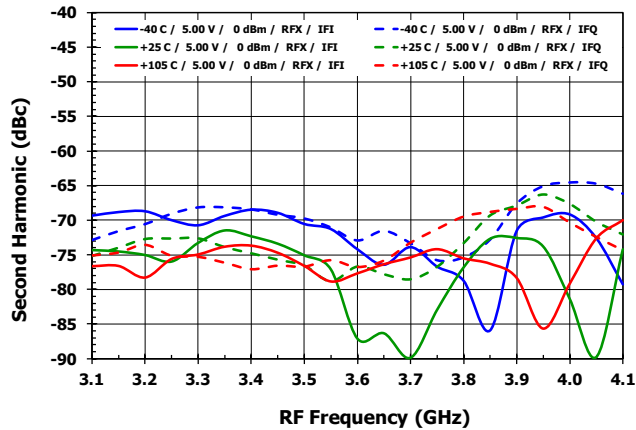


DPD Demodulator for PA Linearization

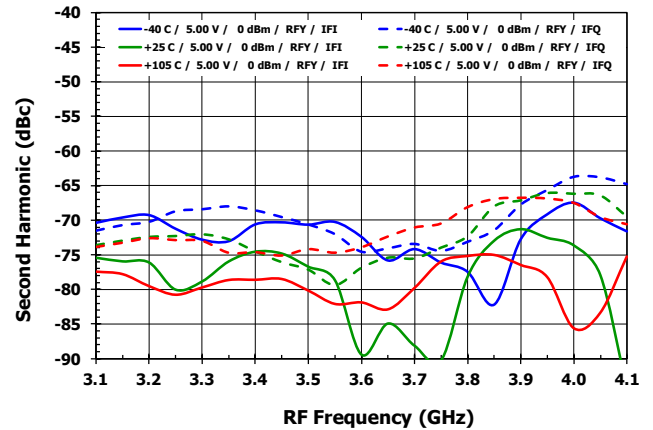
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 8 -)

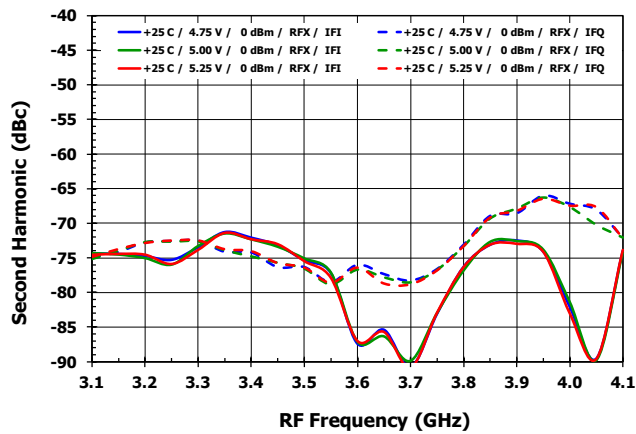
2nd Harmonic vs. T_{case} [High Side LO, RF_X, P_{IF}=-6 dBm]



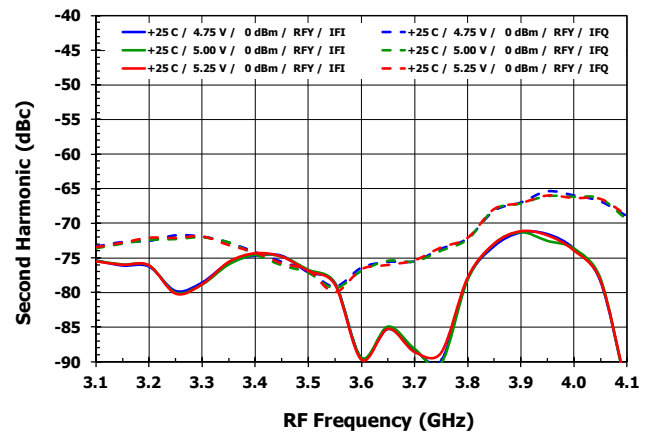
2nd Harmonic vs. T_{case} [High Side LO, RF_Y, P_{IF}=-6 dBm]



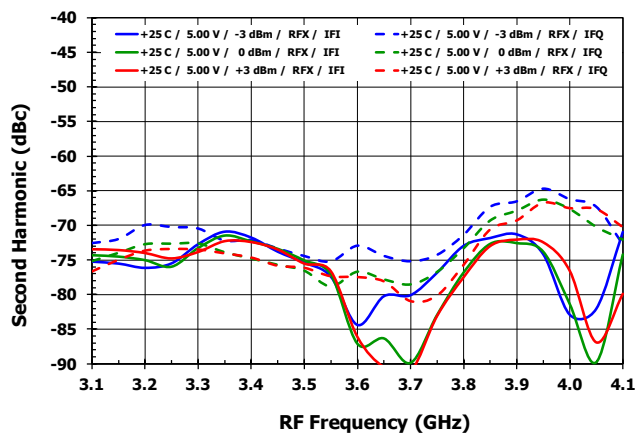
2nd Harmonic vs. V_{cc}[High Side LO, RF_X, P_{IF}=-6 dBm]



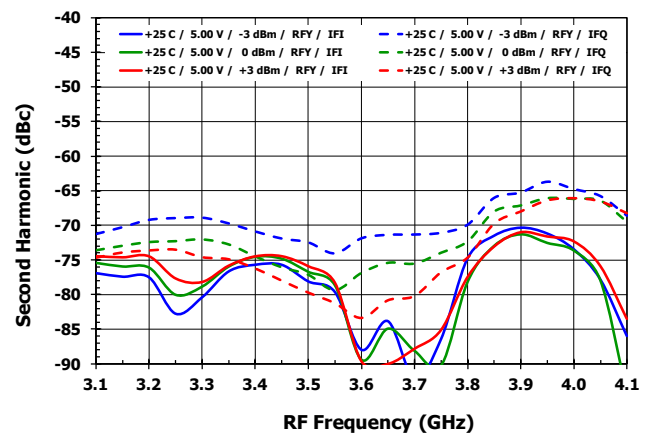
2nd Harmonic vs. V_{cc}[High Side LO, RF_Y, P_{IF}=-6 dBm]



2nd Harmonic vs. LO Power [High Side LO, RF_X, P_{IF}=-6 dBm]



2nd Harmonic vs. LO Power [High Side LO, RF_Y, P_{IF}=-6 dBm]



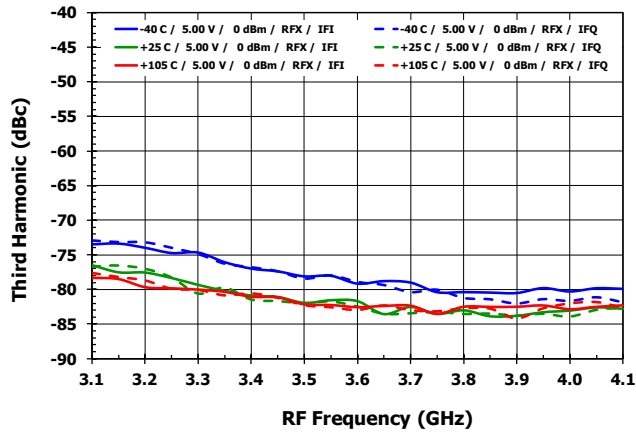


DPD Demodulator for PA Linearization

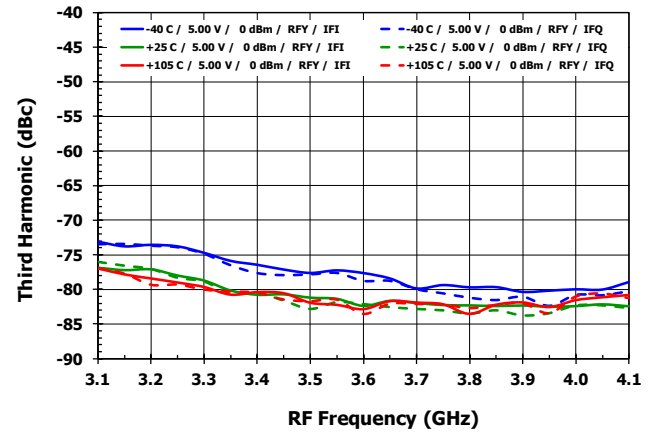
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 9 -)

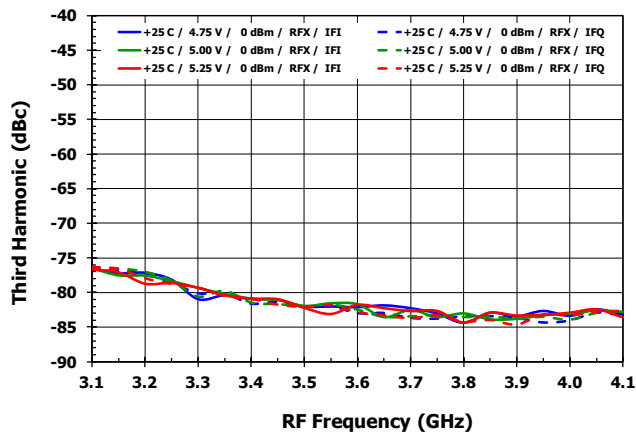
3rd Harmonic vs. T_{case} [Low Side LO, RF_X]



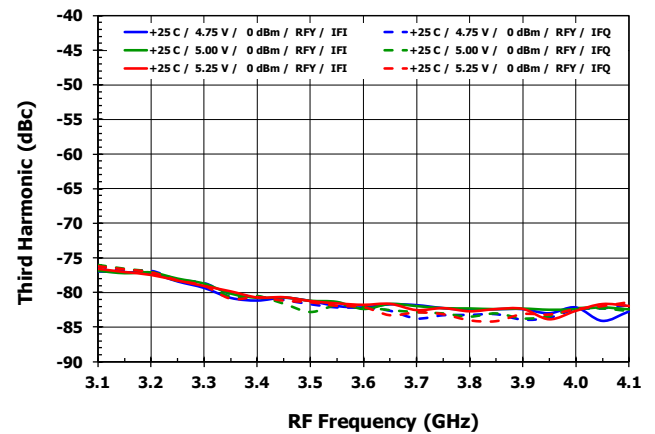
3rd Harmonic vs. T_{case} [Low Side LO, RF_Y]



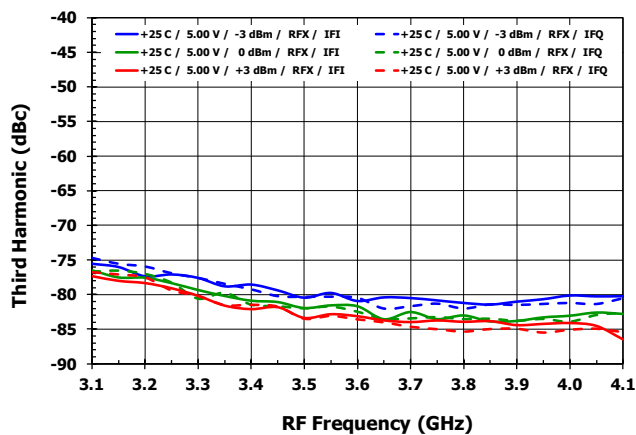
3rd Harmonic vs. V_{cc}[Low Side LO, RF_X]



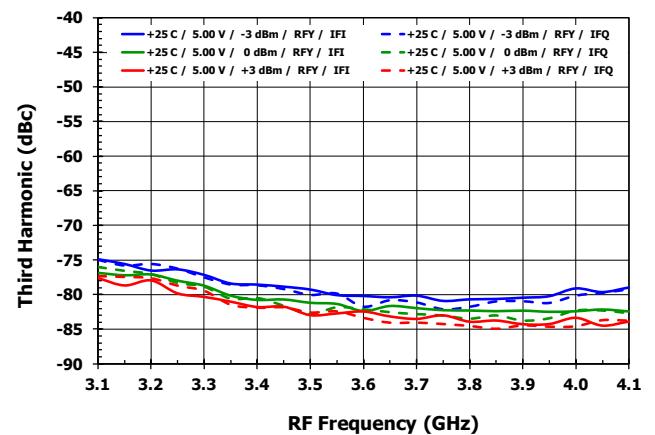
3rd Harmonic vs. V_{cc}[Low Side LO, RF_Y]



3rd Harmonic vs. LO Power [Low Side LO, RF_X]



3rd Harmonic vs. LO Power [Low Side LO, RF_Y]



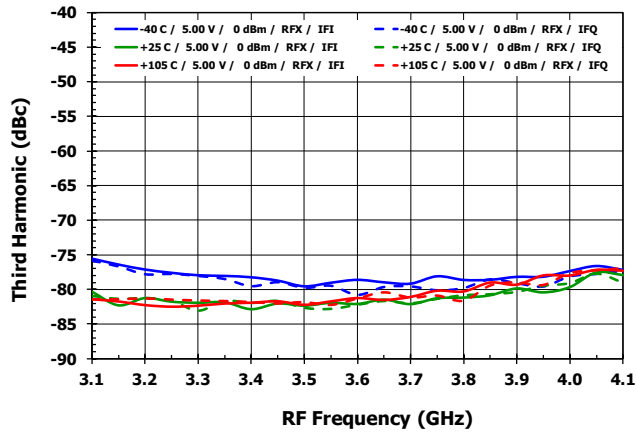


DPD Demodulator for PA Linearization

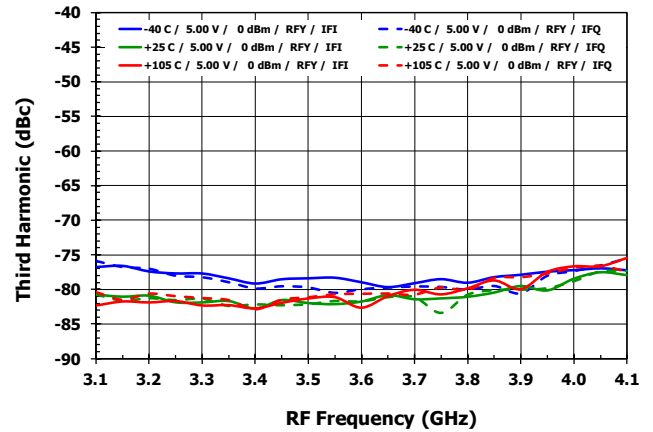
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 10 -)

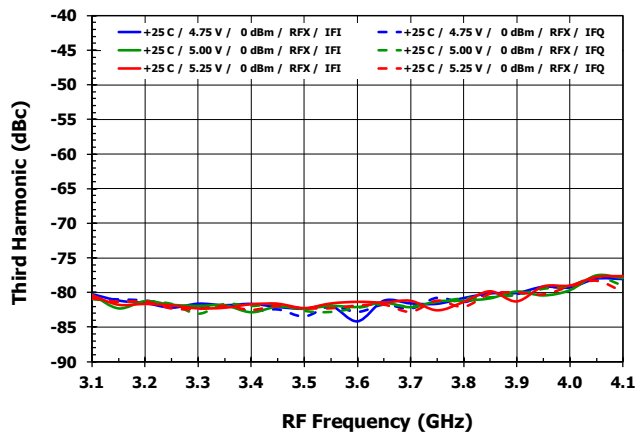
3rd Harmonic vs. T_{case} [High Side LO, RF_X]



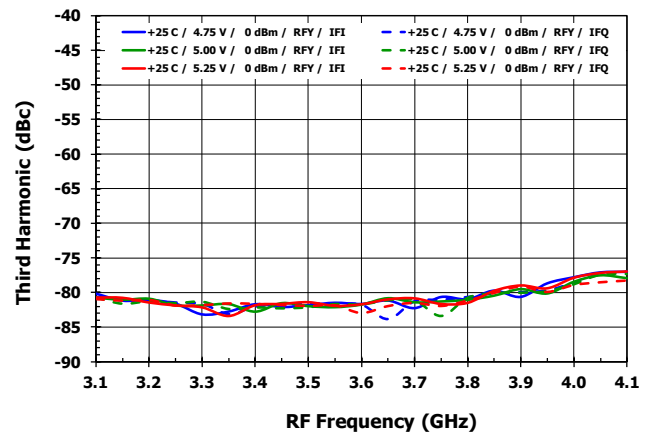
3rd Harmonic vs. T_{case} [High Side LO, RF_Y]



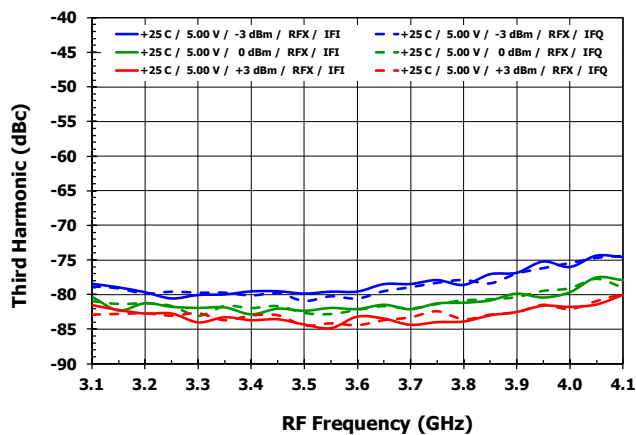
3rd Harmonic vs. V_{cc}[High Side LO, RF_X]



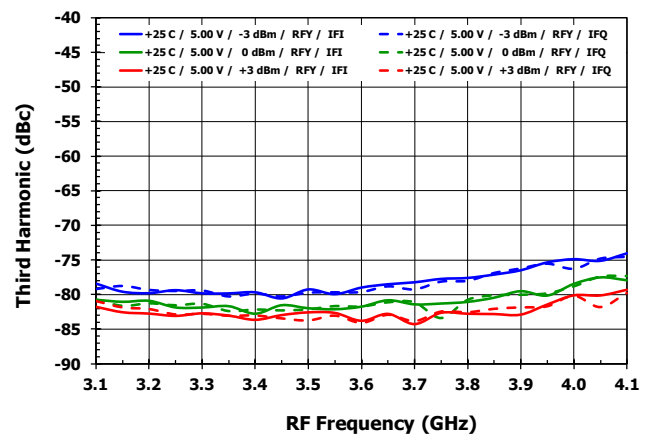
3rd Harmonic vs. V_{cc}[High Side LO, RF_Y]



3rd Harmonic vs. LO Power [High Side LO, RF_X]



3rd Harmonic vs. LO Power [High Side LO, RF_Y]



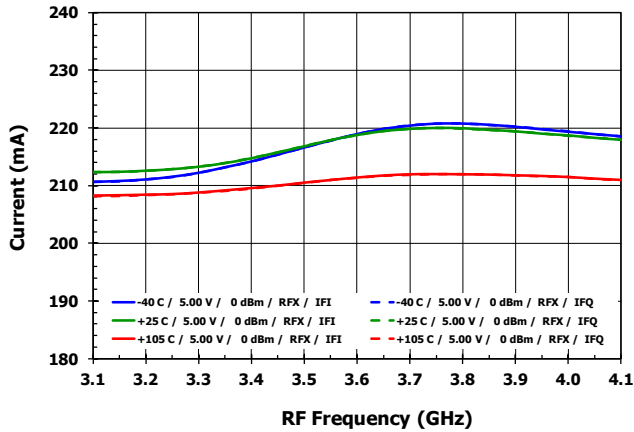


DPD Demodulator for PA Linearization

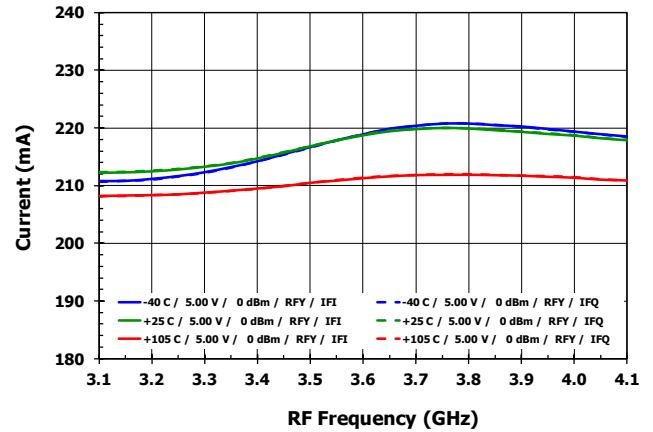
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 11 -)

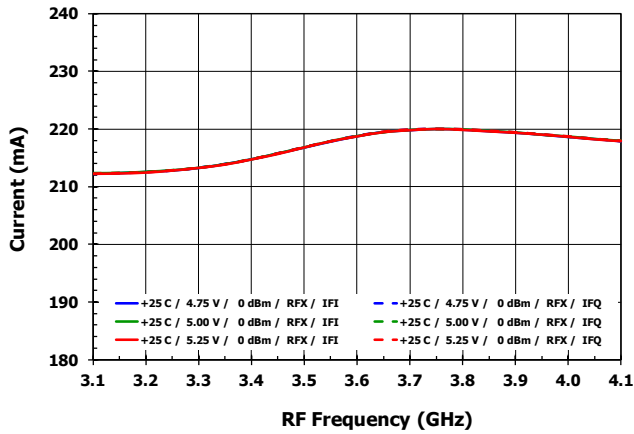
Current vs. T_{case} [Low Side LO, RF_X]



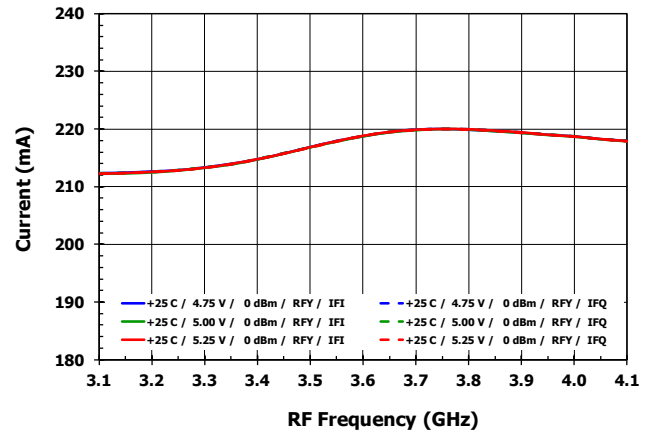
Current vs. T_{case} [Low Side LO, RF_Y]



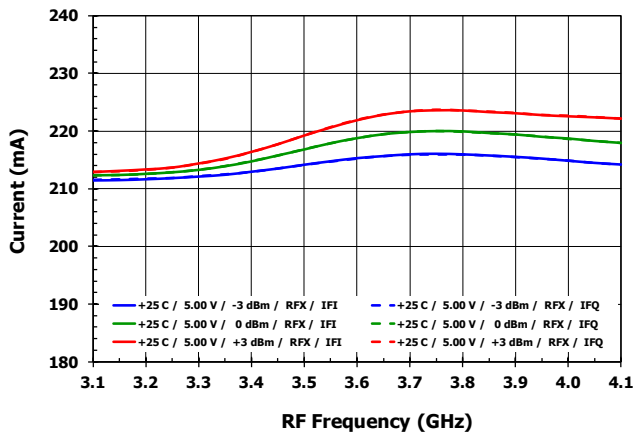
Current vs. V_{cc} [Low Side LO, RF_X]



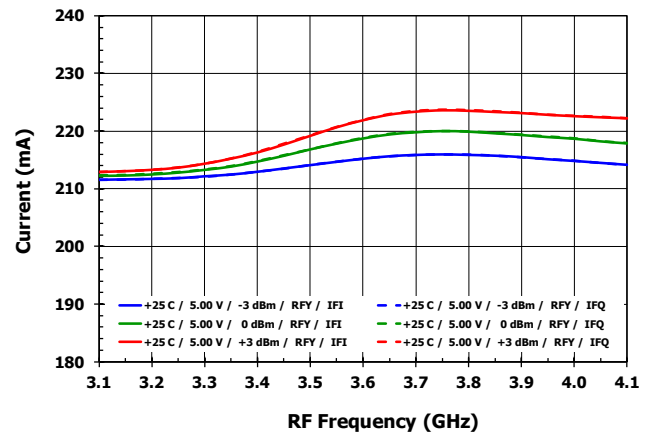
Current vs. V_{cc} [Low Side LO, RF_Y]



Current vs. LO Power [Low Side LO, RF_X]



Current vs. LO Power [Low Side LO, RF_Y]

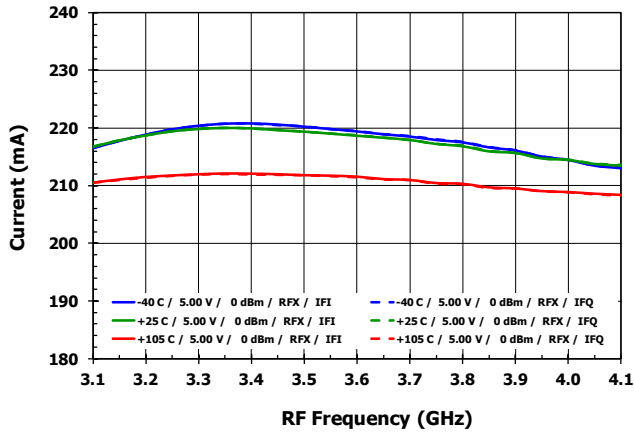


DPD Demodulator for PA Linearization

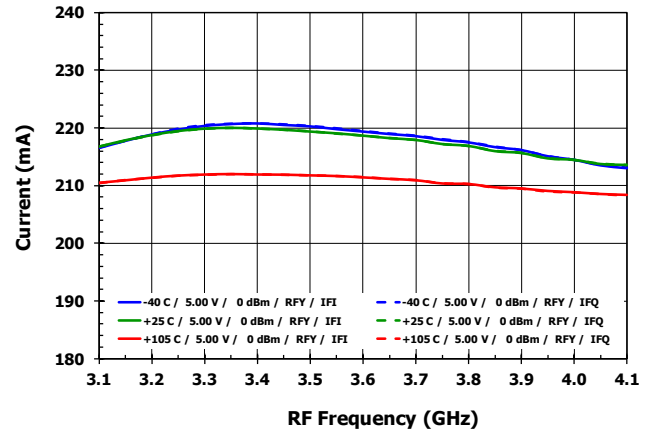
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 12 -)

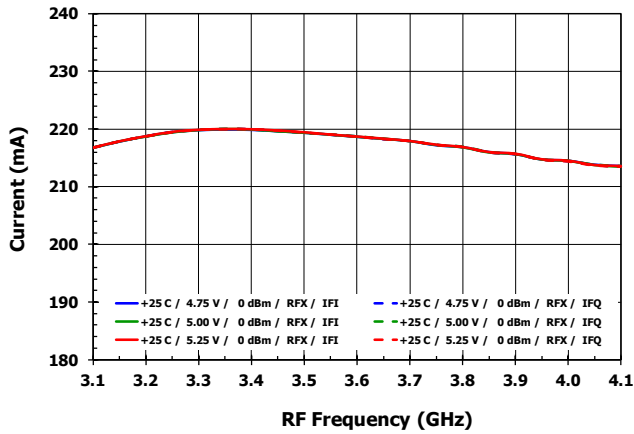
Current vs. T_{case} [High Side LO, RF_X]



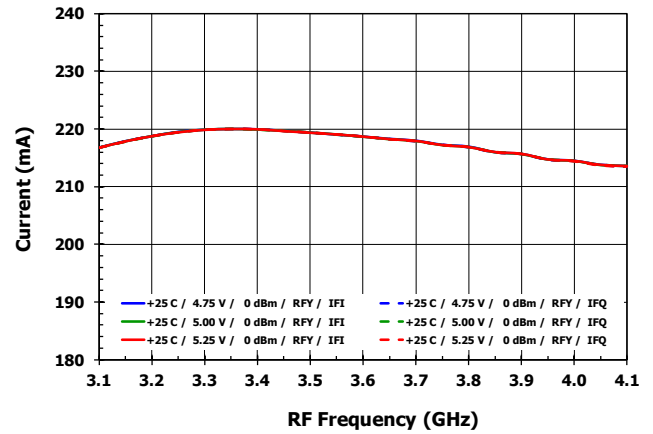
Current vs. T_{case} [High Side LO, RF_Y]



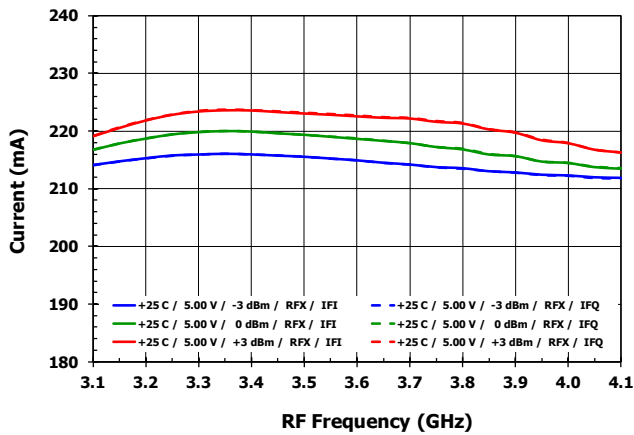
Current vs. V_{cc} [High Side LO, RF_X]



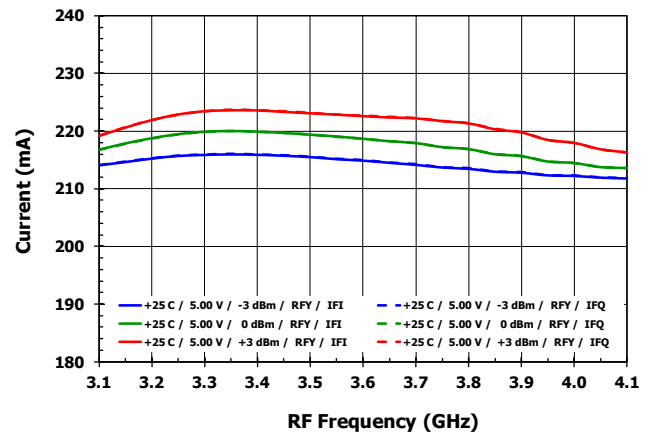
Current vs. V_{cc} [High Side LO, RF_Y]



Current vs. LO Power [High Side LO, RF_X]



Current vs. LO Power [High Side LO, RF_Y]



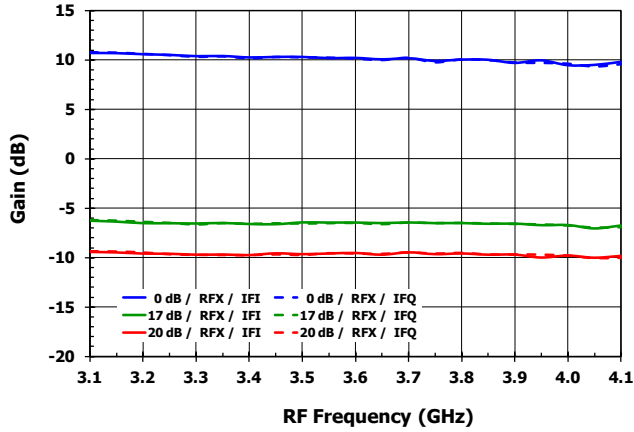


DPD Demodulator for PA Linearization

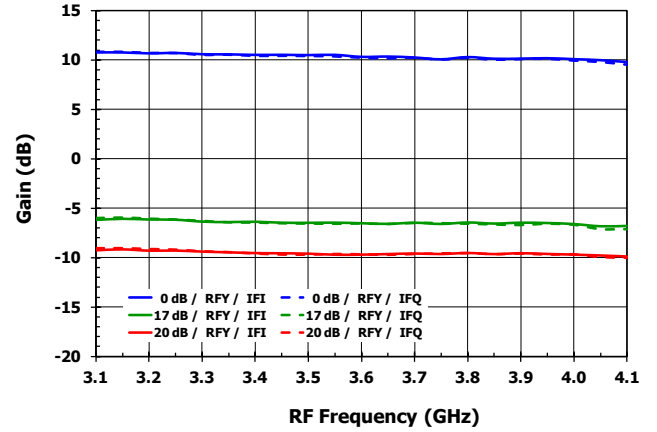
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 13 -)

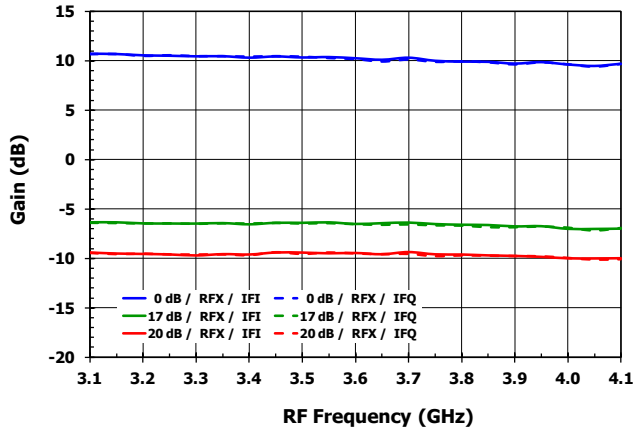
Gain vs. Attenuator Setting [Low Side LO, RF_X]



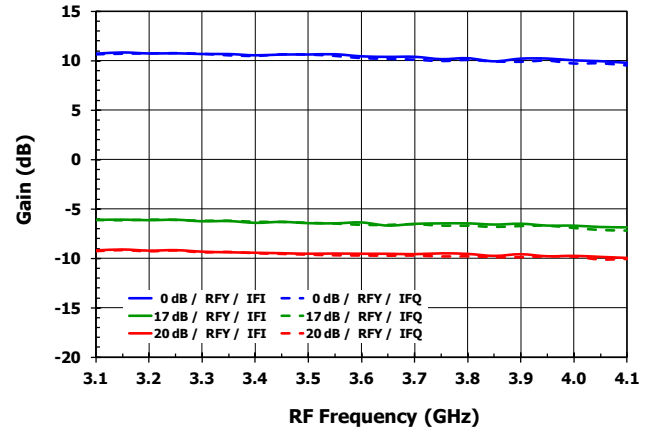
Gain vs. Attenuator Setting [Low Side LO, RF_Y]



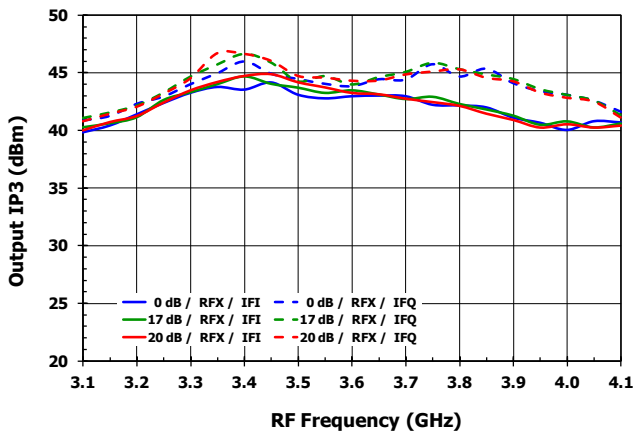
Gain vs. Attenuator Setting [High Side LO, RF_X]



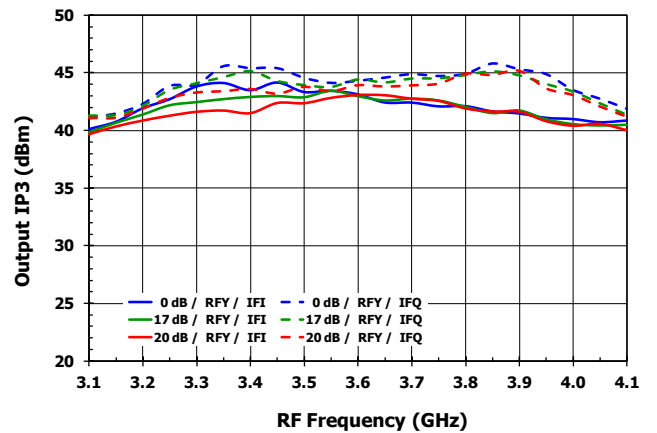
Gain vs. Attenuator Setting [High Side LO, RF_Y]



OIP3 vs. Attenuation Setting [Low Side LO, RF_X]



OIP3 vs. Attenuation Setting [Low Side LO, RF_Y]



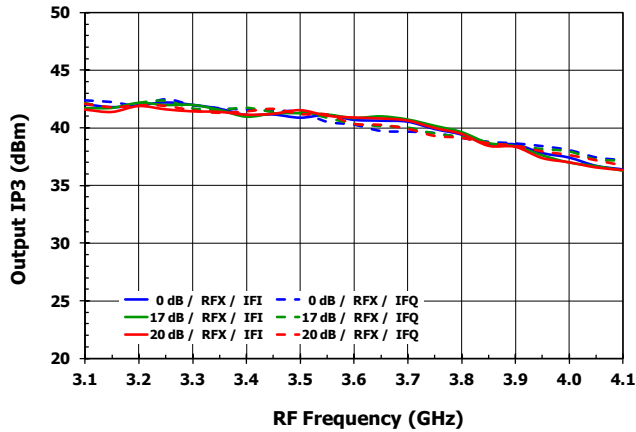


DPD Demodulator for PA Linearization

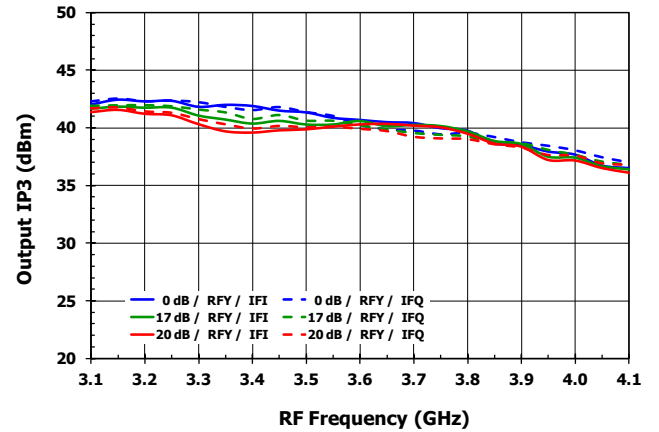
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 14 -)

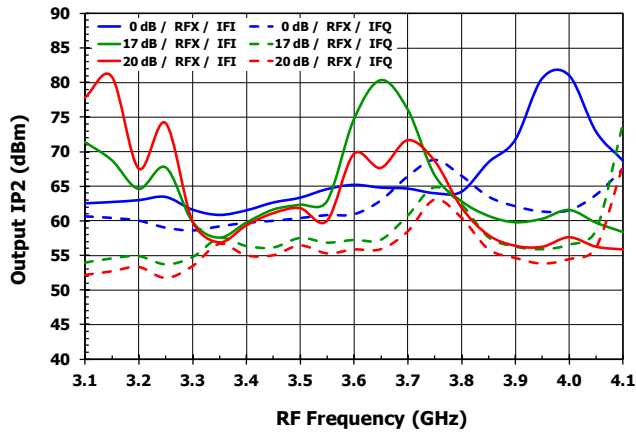
OIP3 vs. Attenuation Setting [High Side LO, RF_X]



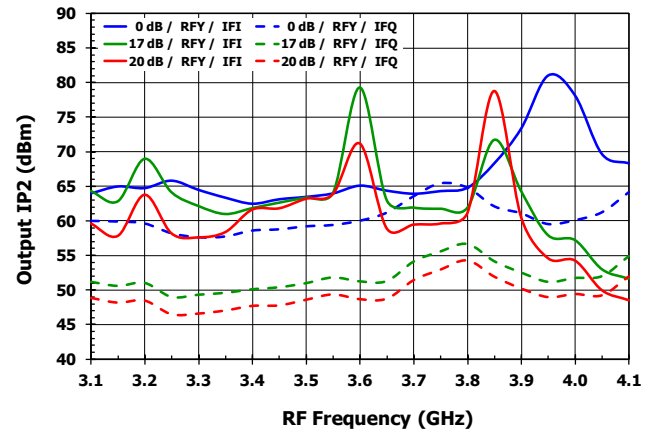
OIP3 vs. Attenuation Setting [High Side LO, RF_Y]



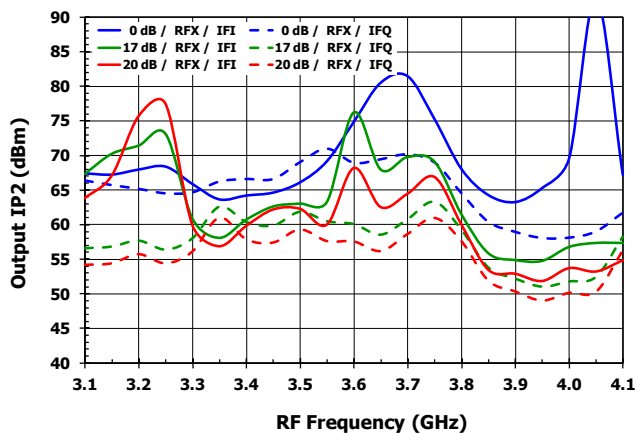
OIP2 vs. Attenuation Setting [Low Side LO, RF_X]



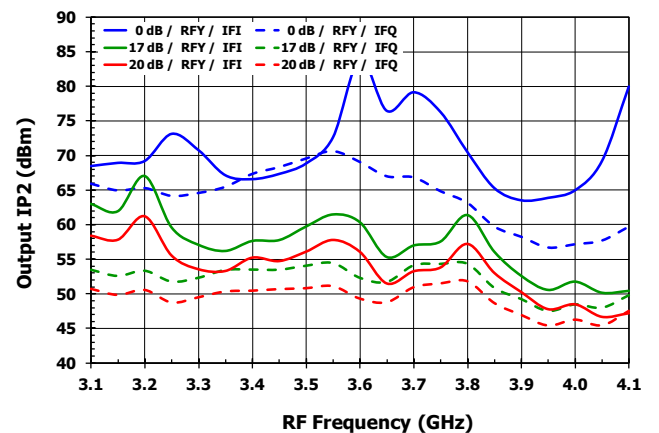
OIP2 vs. Attenuation Setting [Low Side LO, RF_Y]



OIP2 vs. Attenuation Setting [High Side LO, RF_X]



OIP2 vs. Attenuation Setting [High Side LO, RF_Y]

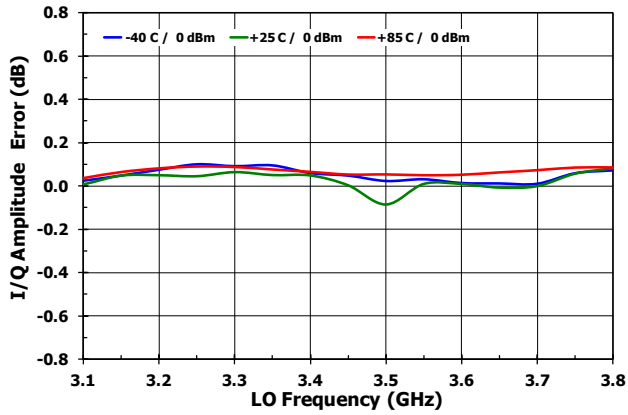


DPD Demodulator for PA Linearization

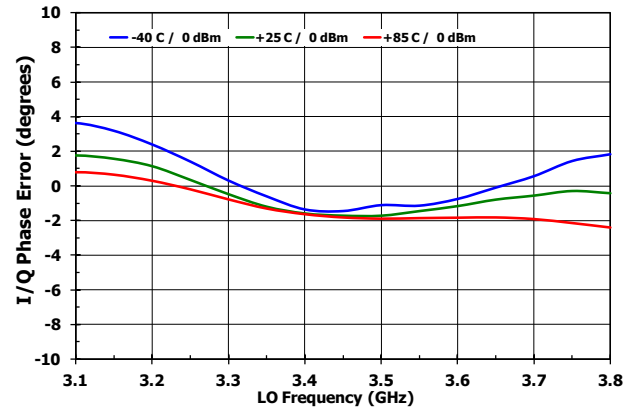
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 15 -)

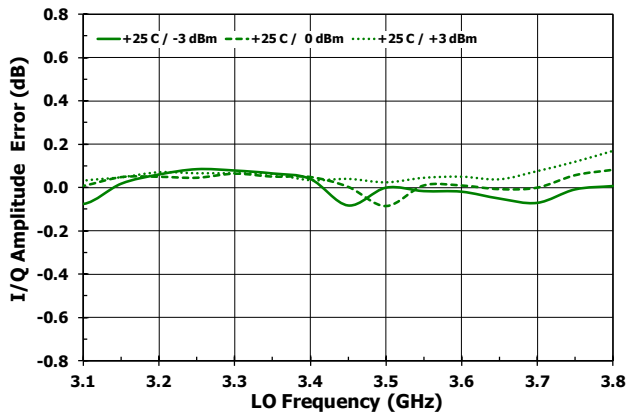
Amplitude Imbalance vs $T_{Ambient}$ [$P_{LO} = 0$ dBm]



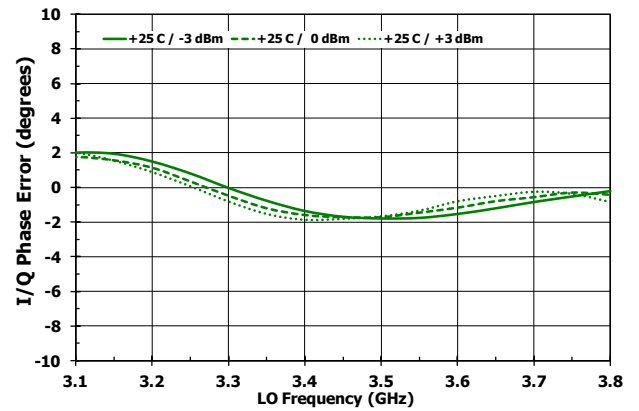
Phase Imbalance vs $T_{Ambient}$ [$P_{LO} = 0$ dBm]



Amplitude Imbalance vs LO Power [$T_{Ambient}$]



Phase Imbalance vs LO Power [$T_{Ambient}$]

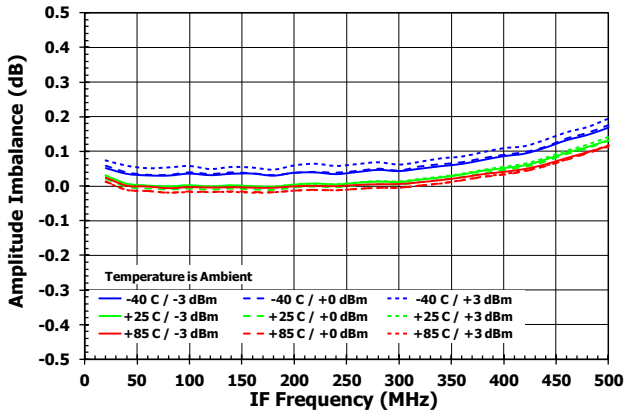


DPD Demodulator for PA Linearization

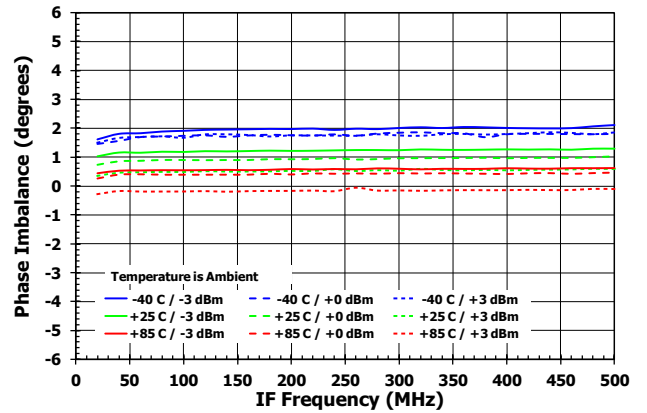
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 16 -)

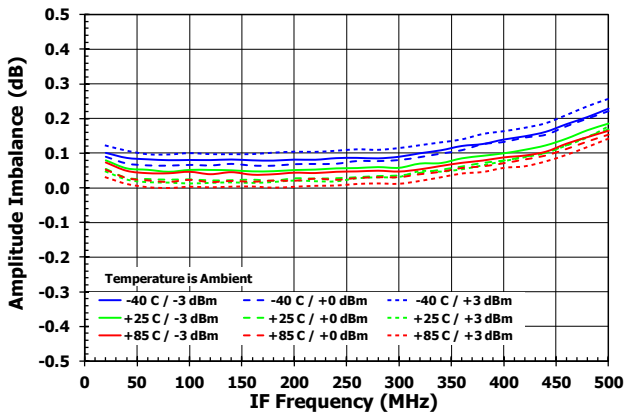
Amplitude Imbalance [$F_{LO} = 3.155$ GHz]



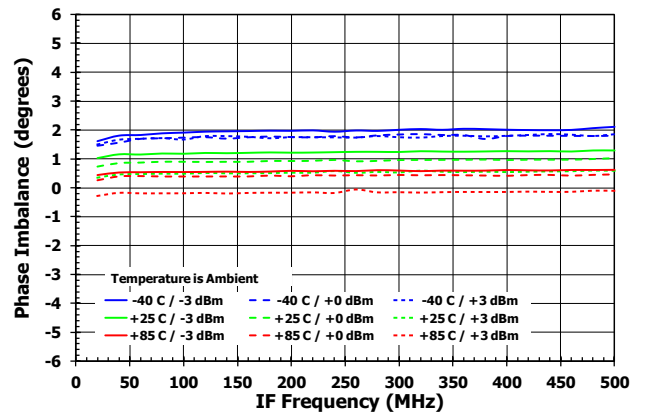
Phase Imbalance [$F_{LO} = 3.155$ GHz]



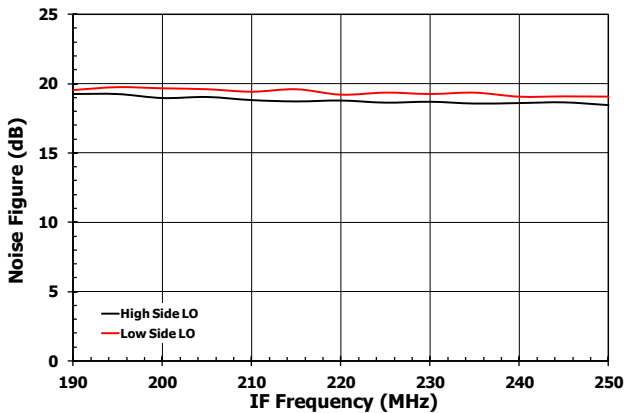
Amplitude Imbalance [$F_{LO} = 3.255$ GHz]



Phase Imbalance [$F_{LO} = 3.255$ GHz]



Noise Figure [$F_{LO}=3.48$ GHz]

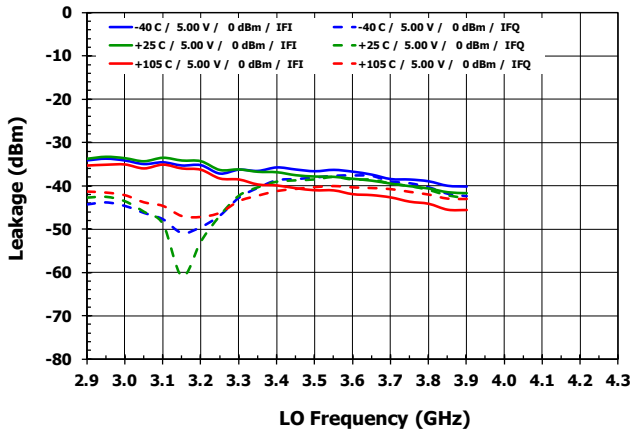


DPD Demodulator for PA Linearization

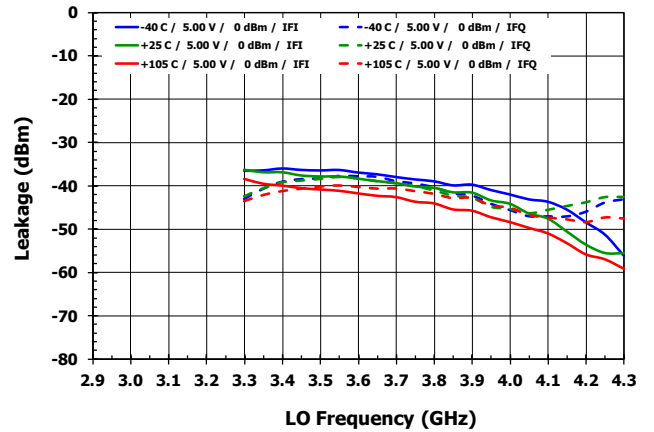
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 17 -)

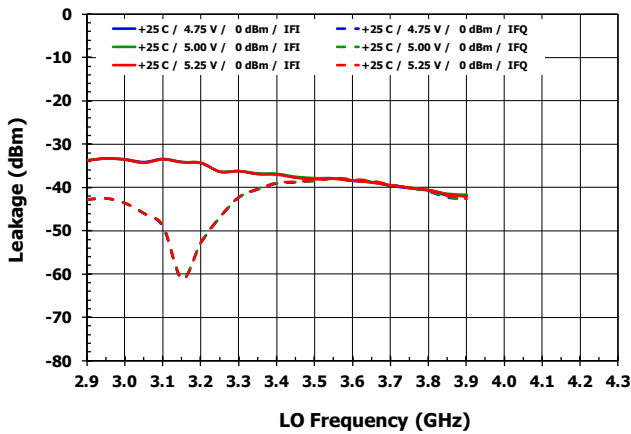
LO to IF Leakage vs. T_{case} [Low Side LO]



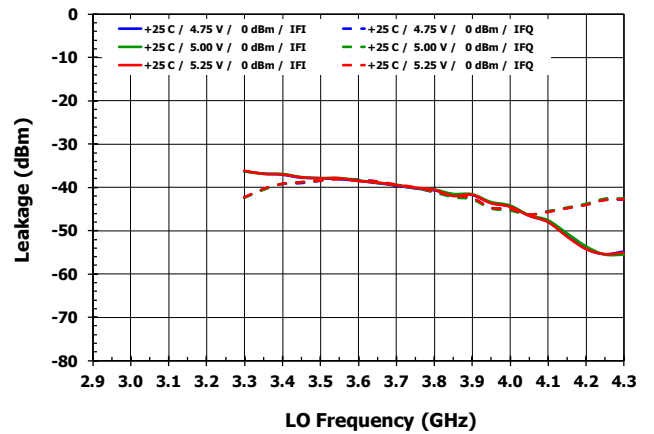
LO to IF Leakage vs. T_{case} [High Side LO]



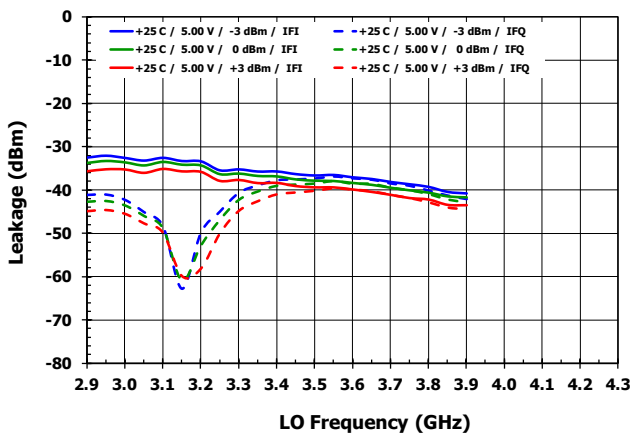
LO to IF Leakage vs. V_{cc} [Low Side LO]



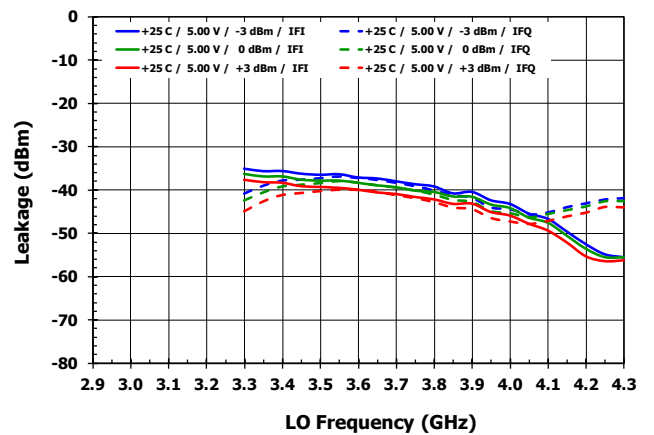
LO to IF Leakage vs. V_{cc} [High Side LO]



LO to IF Leakage vs. LO Power [Low Side LO]



LO to IF Leakage vs. LO Power [High Side LO]



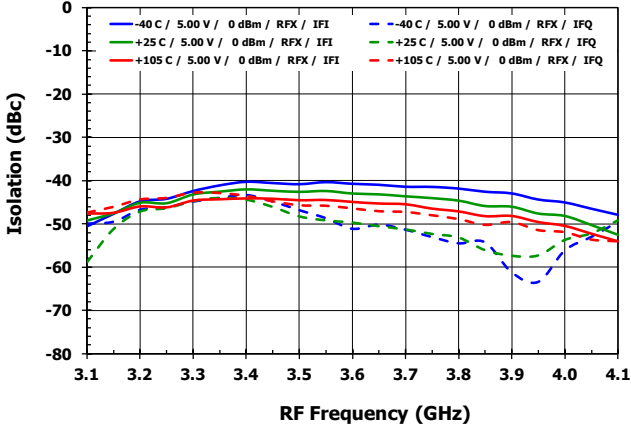


DPD Demodulator for PA Linearization

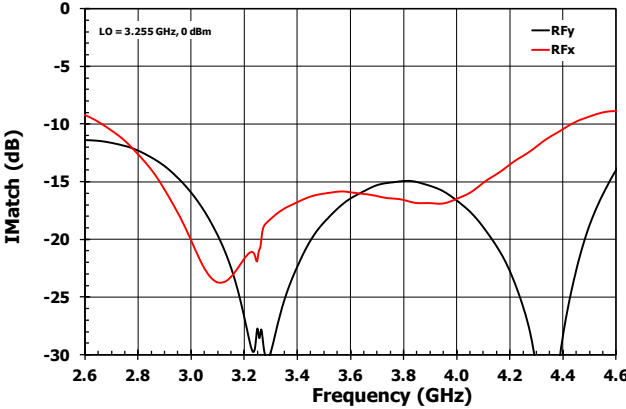
3200 MHz to 4000 MHz

TYPICAL OPERATING CONDITIONS (- 18 -)

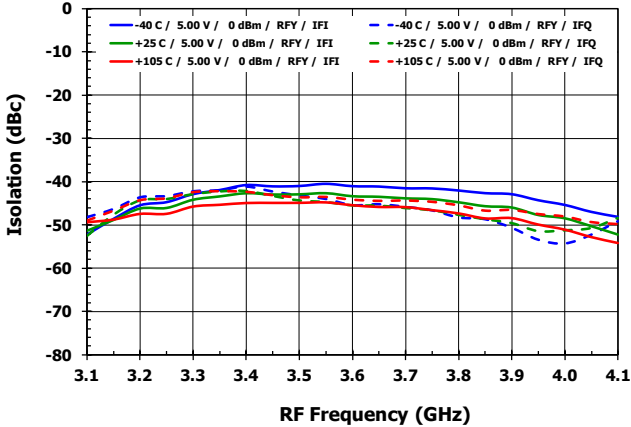
RF_X to IF Isolation



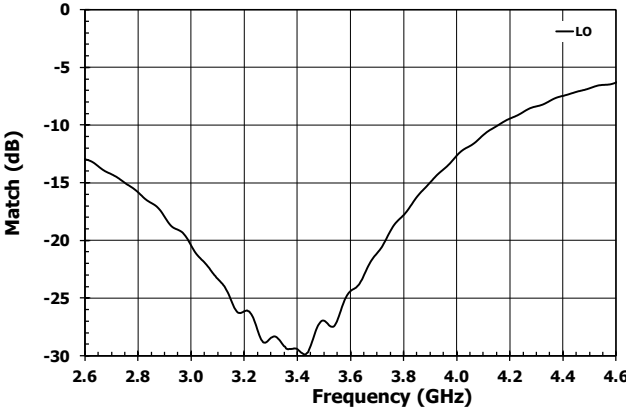
RF Match



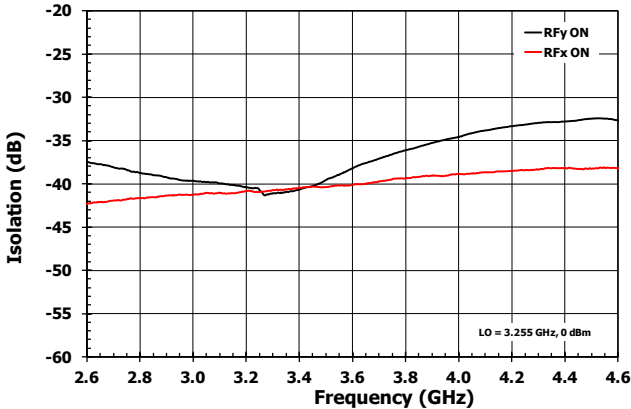
RF_Y to IF Isolation



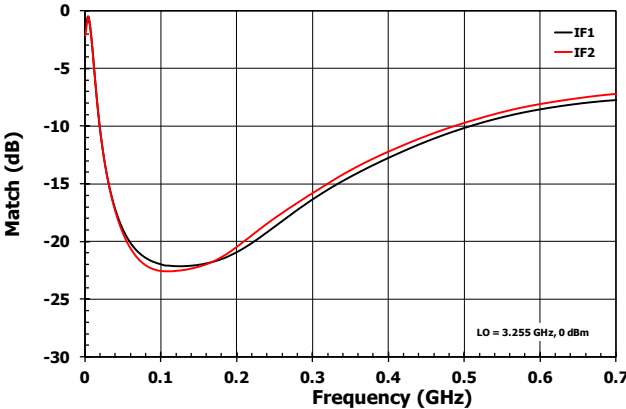
LO Match



RF Switch Isolation



IF Match



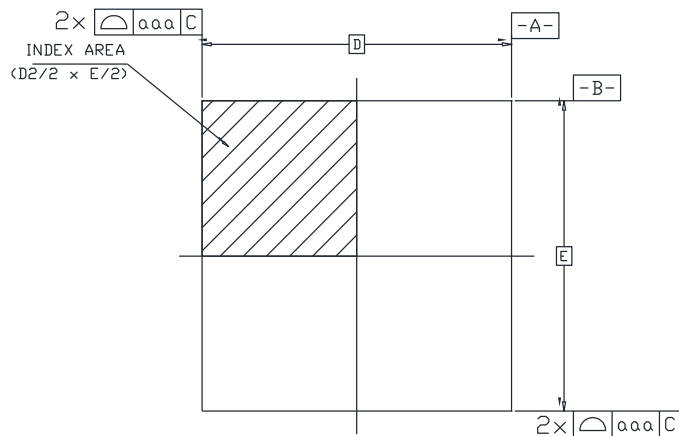
DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

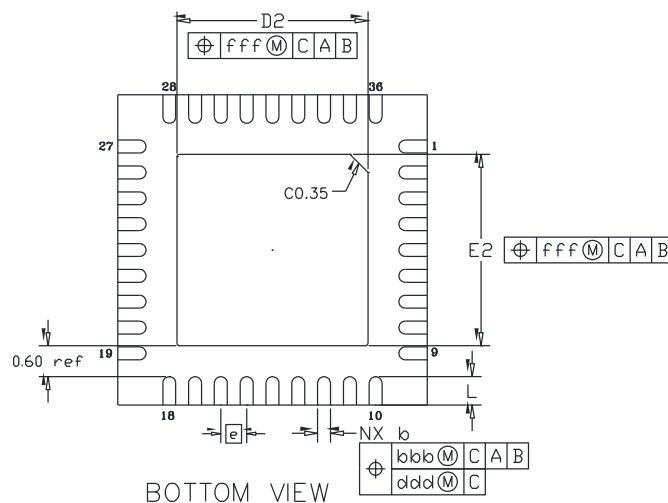
PACKAGE DRAWING

(6mm x 6mm 36-pin TQFN), NBG36 EPad option P1

All dimensions are in mm.

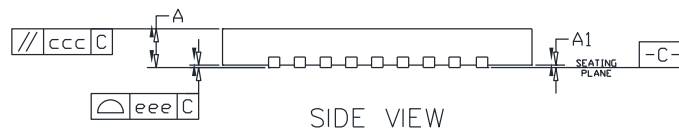


TOP VIEW



BOTTOM VIEW

SYMBOL	DIMENSION		
	MIN	NOM	MAX
L	0.45	0.55	0.65
D	6.00 BSC		
E	6.00 BSC		
e	0.50 BSC		
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
b	.20	.25	.30
aaa	0.15		
bbb	0.10		
ccc	0.10		
ddd	0.05		
eee	0.08		
fff	0.10		



SIDE VIEW

EPAD OPTION

SYMBOL	P1			P2		
	MIN	NOM	MAX	MIN	NOM	MAX
E2	3.60	3.70	3.80	4.00	4.10	4.20
D2	3.60	3.70	3.80	4.00	4.10	4.20

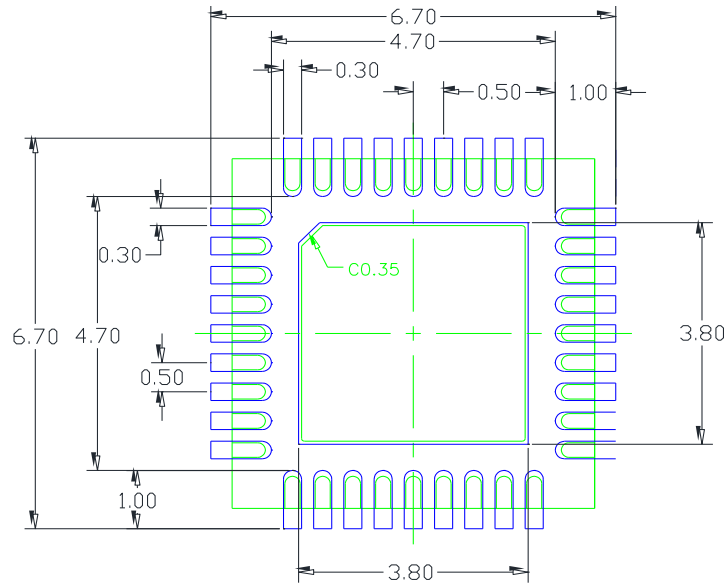
NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSIONS ARE IN MILLIMETERS.

DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

LAND PATTERN DIMENSION



RECOMMENDED LAND PATTERN DIMENSION

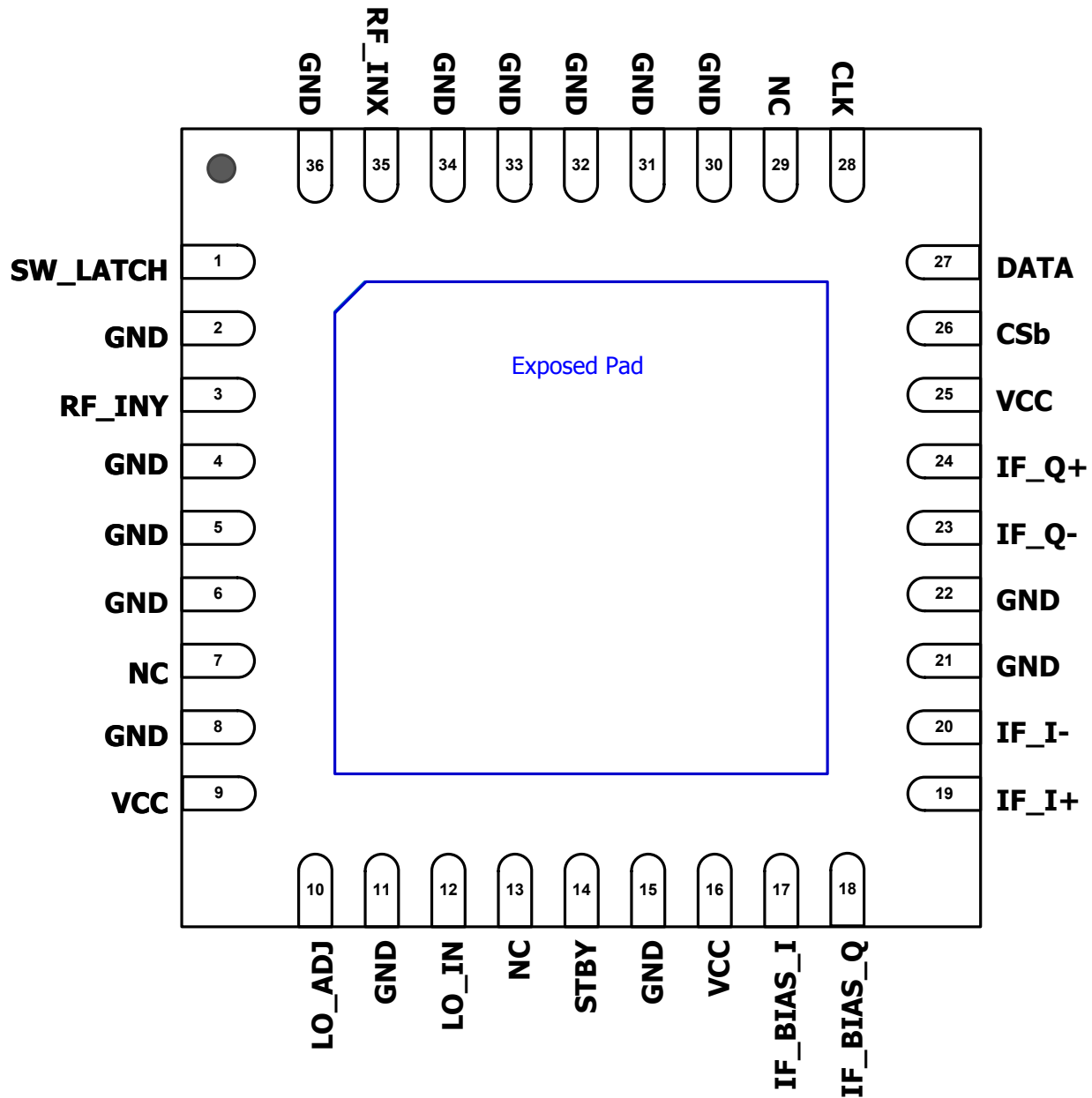
NOTES:

1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW, AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

PIN DIAGRAM





DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

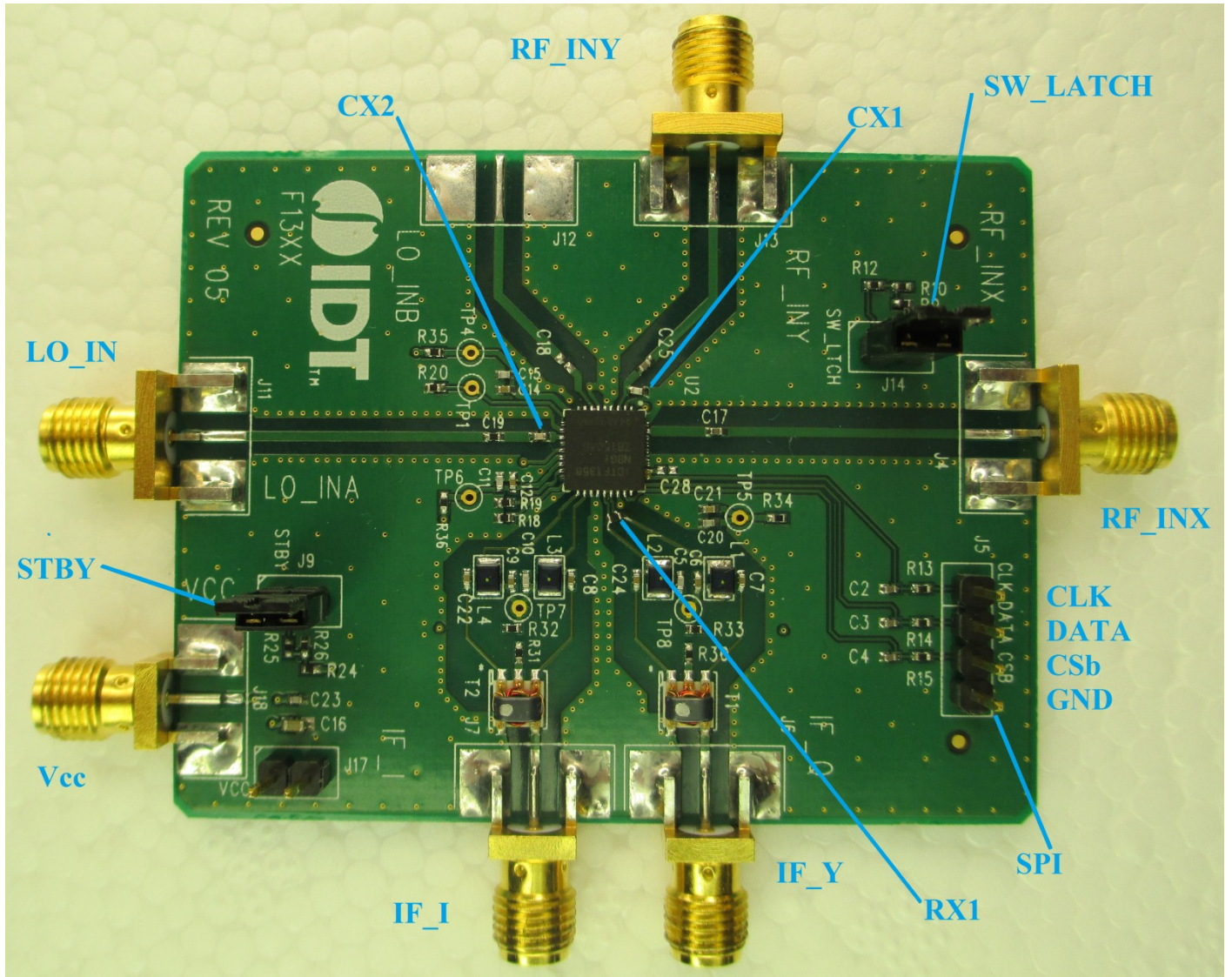
PIN DESCRIPTION

Pin	Name	Function
1	SW_LATCH	Stand-by latch. Pull Low or Ground for Normal Operation. If left floating, this input will be internally pulled high, disabling SPI writes to ENb (Standby) and RF SW bits (A0, A2).
2, 4, 5, 6, 8, 11, 15, 21, 22, 30, 31, 32, 33, 34, 36	GND	Ground these Pins.
3	RF_INY	Alternate RF Input. Separated from RF_INX by internal SP2T. AC couple to this pin. This is a reflective switch and is not internally matched to 50 ohms.
9, 16, 25	VCC	Power Supply. Bypass to GND with capacitors shown in the Typical Application Circuit as close as possible to pin.
10	LO_ADJ	Connect the specified resistor from this pin to ground to set the LO path I_{CC} . This IS a current setting resistor
12	LO_IN	LO Input. AC couple to this pin. Internally matched to 50 ohms
7, 13, 29	NC	No Connection. Not internally connected. OK to connect to Vcc. Recommended Connection is Ground
14	STBY	STBY Mode. Pull this pin high for Standby mode (30mA). Pull low or Ground for normal Operation
17, 18	IF_BIAS_I IF_BIAS_Q	Connect the specified resistor from this pin to ground to set the IF amplifier bias reference. This is NOT a current setting resistor.
19, 20	IF_I+ IF_I-	<i>In-Phase</i> Mixer Differential IF Output. Connect pull-up inductors from each of these pins to V _{CC} (see the Typical Application Circuit).
23, 24	IF_Q- IF_Q+	<i>Quadrature</i> Mixer Differential IF Output. Connect pull-up inductors from each of these pins to V _{CC} (see the Typical Application Circuit).
26	CSb	Chip Select Bar. The falling edge initiates a programming cycle and the rising edge latches the programmed shift register data into the active register.
27	DATA	Serial Data Input
28	CLK	Serial Clock Input
35	RF_INX	Main RF Input. Separated from RF_INY by internal SP2T. AC couple to this pin. This is a reflective switch and is not internally matched to 50 ohms.
	— EP	Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple via grounds are also required to achieve the noted RF performance.

DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

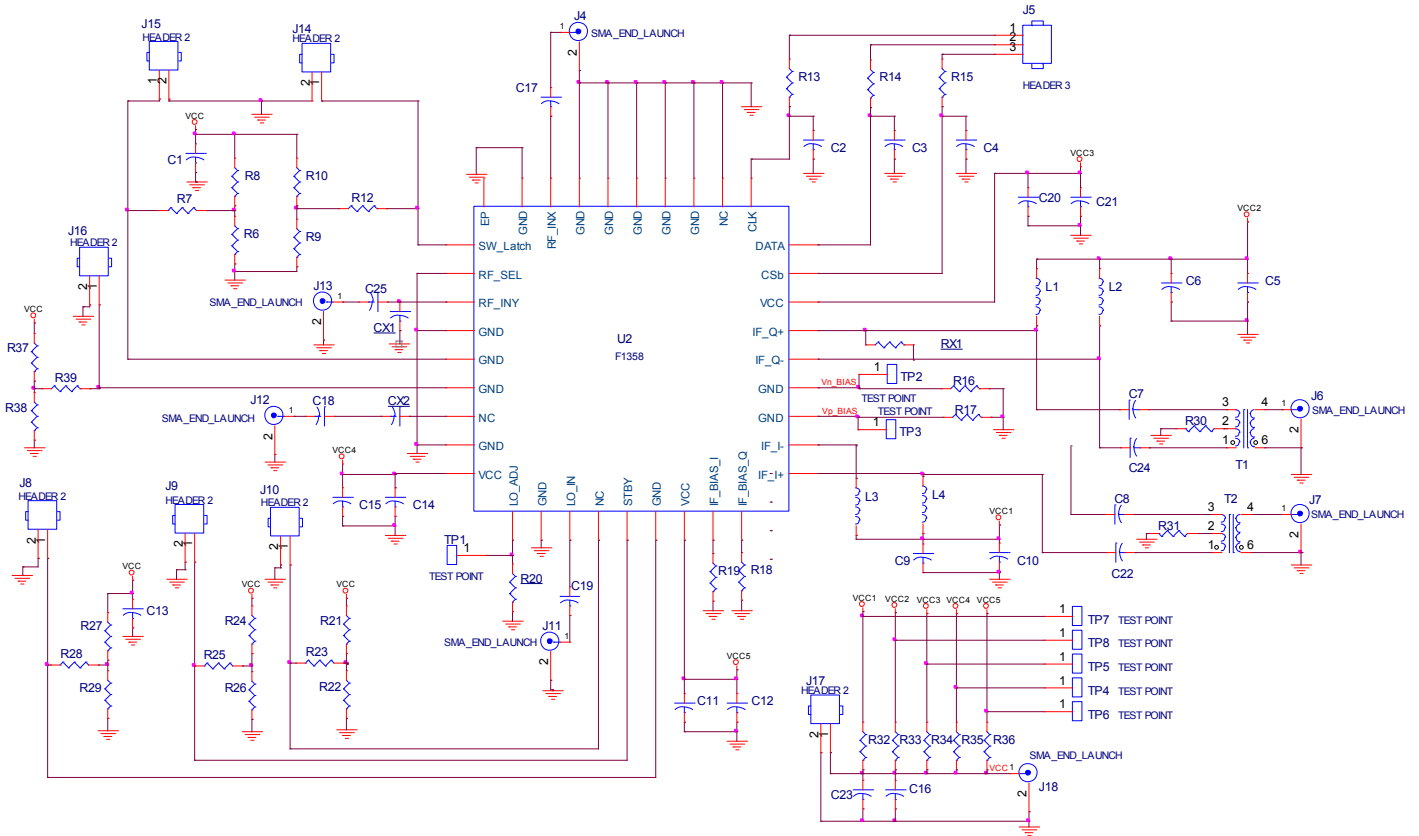
EVKIT PICTURE



Note: Our standard evaluation board is modified with components RX1, CX1, and CX2

DPD Demodulator for PA Linearization EVKIT / APPLICATIONS CIRCUIT

3200 MHz to 4000 MHz



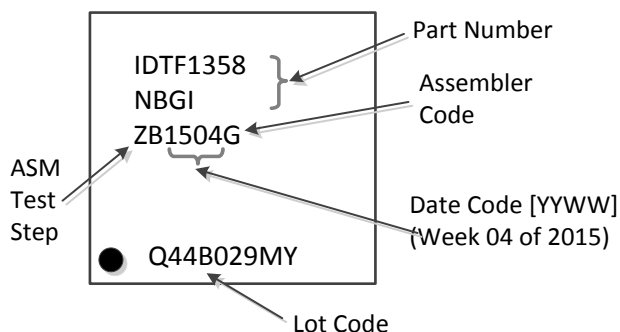
DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

EVKIT BOM

Item #	Part Reference	QTY	DESCRIPTION	Mfr. Part #	Mfr.
1	C2, C3, C4	3	100pF ±5%, 50V, COG Ceramic Capacitor (0402)	GRM1555C1H101J	MURATA
2	C6, C7, C8, C9, C12, C14, C21, C22, C24	9	10nF ±5%, 50V, X7R Ceramic Capacitor (0402)	GRM155R71H103J	MURATA
3	C5, C10, C11, C15, C20, C23	6	1000pF ±5%, 50V, COG Ceramic Capacitor (0402)	GRM1555C1H102J	MURATA
4	C17, C25	2	39pF ±5%, 50V, COG Ceramic Capacitor (0402)	GRM1555C1H390J	MURATA
5	C16	1	10uF ±20%, 6.3V, X5R Ceramic Capacitor (0603)	GRM188R60J106M	MURATA
6	CX1	1	0.4pF ±0.05pF, 50V, COG Ceramic Capacitor (0402)	GRM1555C1HR40W	MURATA
7	CX2	1	0.8pF ±0.05pF, 50V, COG Ceramic Capacitor (0402)	GJM1555C1HR80W	MURATA
8	R30, R31, R32, R33, R34, R35, C19	7	0Ω Resistors (0402)	ERJ-2GE0R00X	Panasonic
9	R36	1	20Ω ±1%, 1/10W, Resistor (0402)	ERJ-2RKF20R0X	Panasonic
10	R13, R14, R15	3	100Ω ±1%, 1/10W, Resistor (0402)	ERJ-2RKF1000X	Panasonic
11	R18, R19	2	226Ω ±1%, 1/10W, Resistor (0402)	ERJ-2RKF2260X	Panasonic
12	R20	1	4.3kΩ ±1%, 1/10W, Resistor (0402)	ERJ-2RKF4301X	Panasonic
13	R10, R,24	2	43kΩ ±1%, 1/10W, Resistor (0402)	ERJ-2RKF4302X	Panasonic
14	R12, R25	2	47kΩ ±1%, 1/10W, Resistor (0402)	ERJ-2RKF4702X	Panasonic
15	R9, R26	2	75kΩ ±1%, 1/10W, Resistor (0402)	ERJ-2RKF7502X	Panasonic
16	RX1	1	7.5kΩ ±1%, 1/10W, Resistor (0402)	ERJ-2RKF7501X	Panasonic
17	J9, J14, J17	3	CONN HEADER VERT SGL 2 X 1 POS GOLD	961102-6404-AR	3M
18	J5	1	CONN HEADER VERT SGL 4 X 1 POS GOLD	961104-6404-AR	3M
19	J6, J7, J18	3	Edge Launch SMA (0.250 inch pitch ground, round)	142-0711-821	Emerson Johnson
20	J4, J11, J13	3	Edge Launch SMA (0.375 inch pitch ground, tab)	142-0701-851	Emerson Johnson
21	L1, L2, L3, L4	4	1uH ±5%, .500A, Ferrite Chip Inductor (0805)	0805LS-102XJLB	COILCRAFT
22	T1, T2	2	1.5-600Mhz 50Ω, RF Transformer (4:1)	TC4-6TG2+	Mini Circuits
23	U1	1	DPD Demodulator	F1358	IDT
24		1	Printed Circuit Board	F13XX REV 05	IDT
25		1	Bill Of Material (Rev 02)		IDT

TOP MARKINGS



DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

APPLICATIONS INFORMATION

F1358 has been optimized for use in high performance RF applications from 3200 MHz to 4000 MHz.

Matching Components

For proper optimization three components were added and one was removed from our standard evaluation board.

Component	Value	Component
RX1	7.5 kΩ	
CX1	0.4 pF	This shunt capacitor is used to create an better match on the second RF input line.
CX2	0.8 pF	This series capacitor must be as close to the package as possible for the best possible match on the LO port.
C18	0 Ω	For better return loss the capacitor was moved closer to the package (CX2). This position was filled with a 0 ohm resistor to span the component gap.

Power Supplies

All supply pins should be bypassed with external capacitors to minimize noise and fast transients. Supply noise can degrade noise figure and fast transients can trigger ESD clamps and cause them to fail. Supply voltage change or transients should have a slew rate smaller than 1V over 20 μS (< 0.05 V/ μS). In addition, all control pins should remain at 0V (+/-0.3V) while the supply voltage ramps or while it returns to zero.

F1358 Digital Pin Voltage & Resistance Values (pins not connected)

The following table lists the resistance between various pins and ground when no DC power is applied. When the device is powered up with +5 Volts DC these same pins to should have the measured voltage to ground.

Pin	Name	DC voltage (volts)	Resistance (ohms)
1	SW_LATCH	1.75	1.6M
14	STBY	5.0	50k
26	CSb	1.75	1.6M
27	DATA	1.75	1.6M
28	CLK	1.75	1.6M



DPD Demodulator for PA Linearization

3200 MHz to 4000 MHz

I/Q Phase Error

The standard configuration results in less than 4 degrees of I/Q Phase error with LO frequencies from 3100 to 3800 MHz. The I/Q phase error can be further improved for a given LO frequency via applications changes. Please contact RFsupport@idt.com for help with your application.

Mouser Electronics

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[IDT \(Integrated Device Technology\):](#)

[F1358NBGI](#) [F1358NBGI8](#) [F1358EVBI](#)